

A 5 Days Long
Workshop and Contest on
PCB Design and
Fabrication



CHIEF GUEST

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Assistant Professor, Dept of EEE, IIUC

Adviser, IEEE Robotics and Automation Society IIUC Student Branch Chapter



3rd April to 7th April, 2021



7:30pm to 9:30pm

Platform



zoom



Organized by



Workshop conducted by

Sayed Tanimun Hasan

Chairperson, IEEE Robotics and Automation Society IIUC Student Branch Chapter

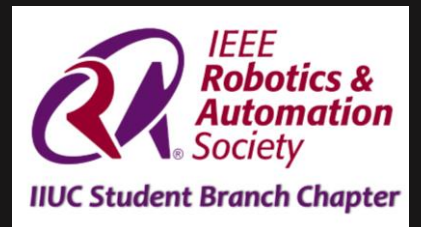
Academic Team Member, Bangladesh Robot Olympiad (BDRO)



Sayed Tanimun Hasan

Chairperson, IEEE RAS IIUC SBC

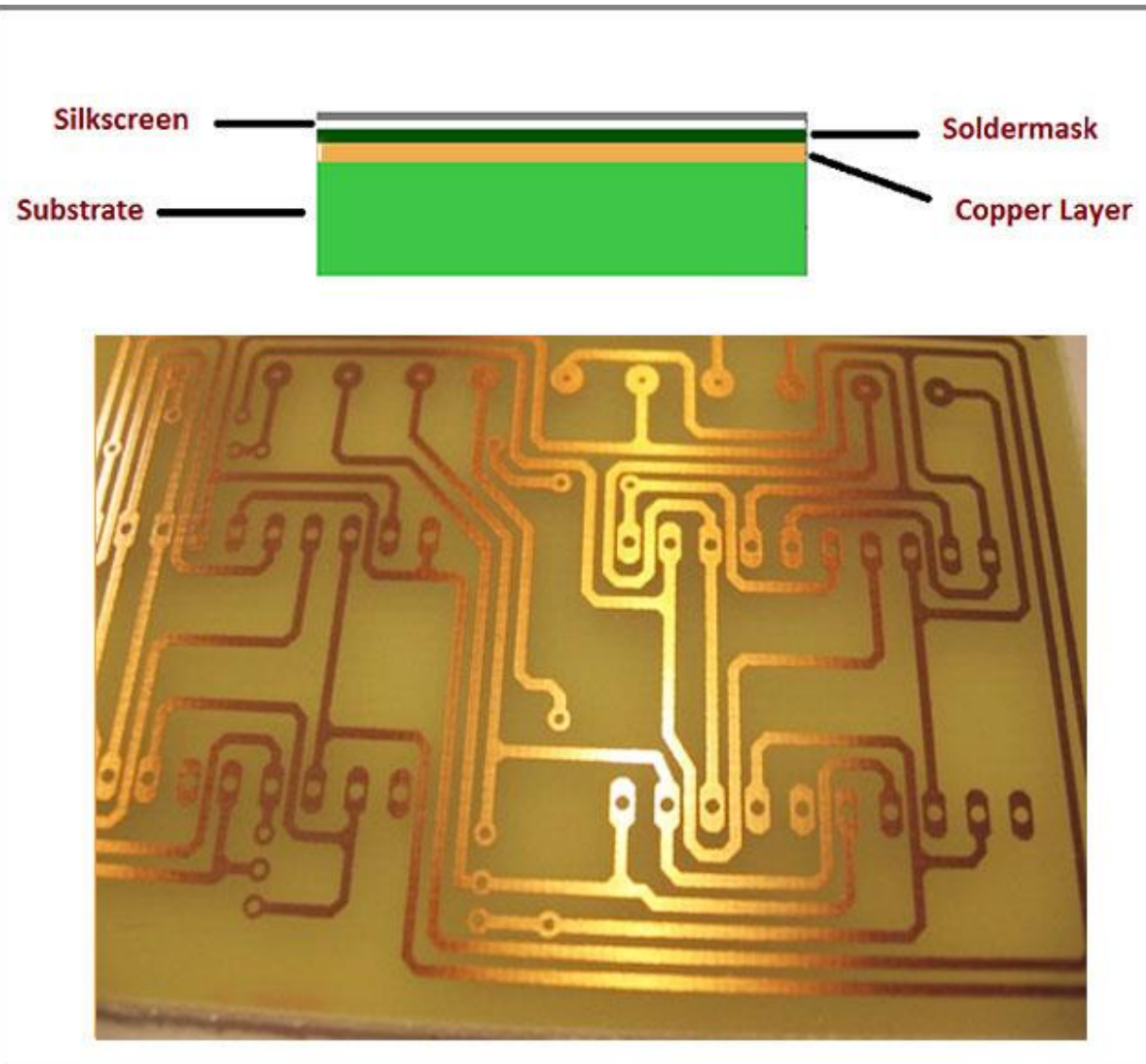
Academic Team Member, Bangladesh Robot Olympiad



What is PCB

- Printed Circuit Board
- Electronic Board that connects circuit components
- PCB populated with electronic components is a printed circuit assembly(PCA)
- PCBs are rugged, inexpensive, and can be highly reliable

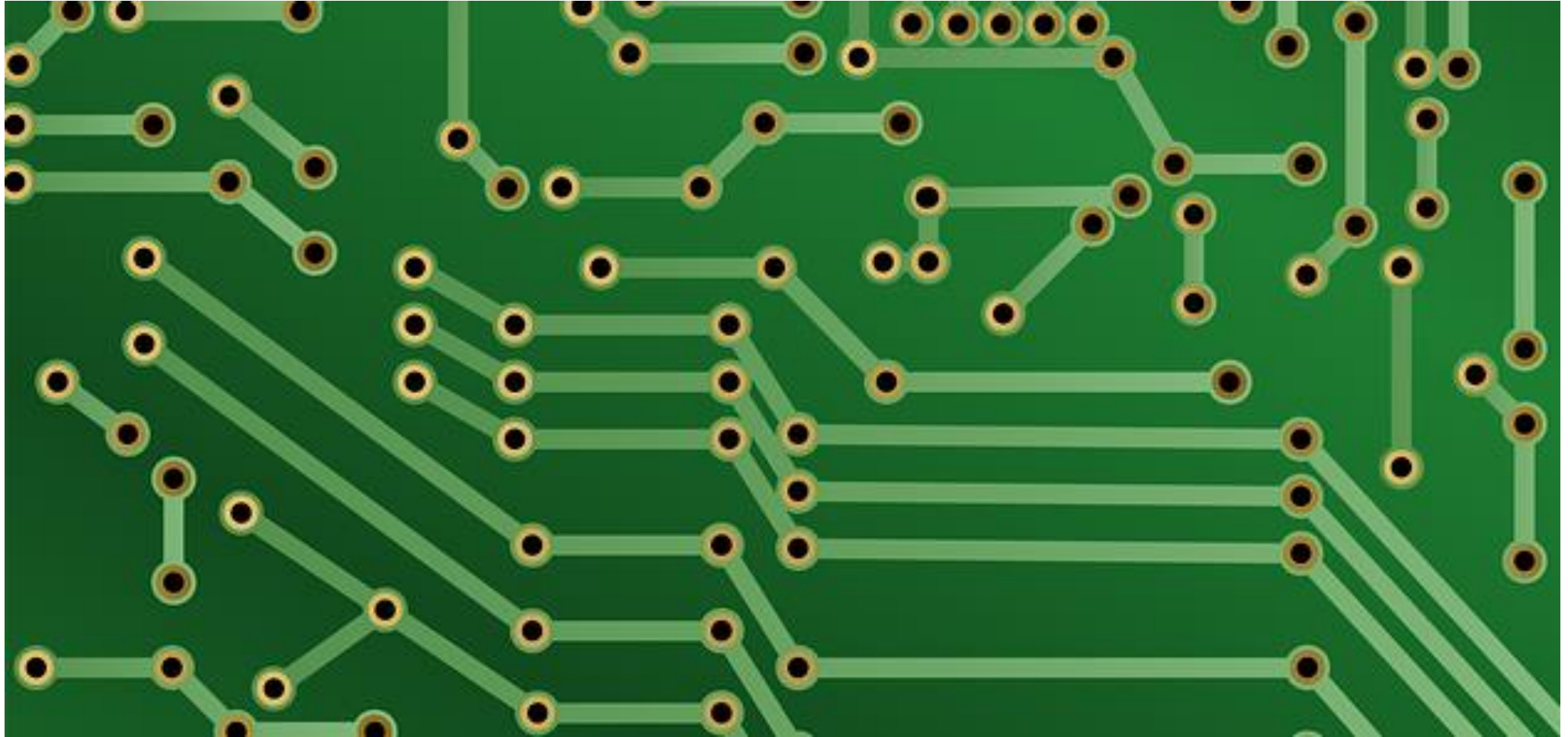
PCB



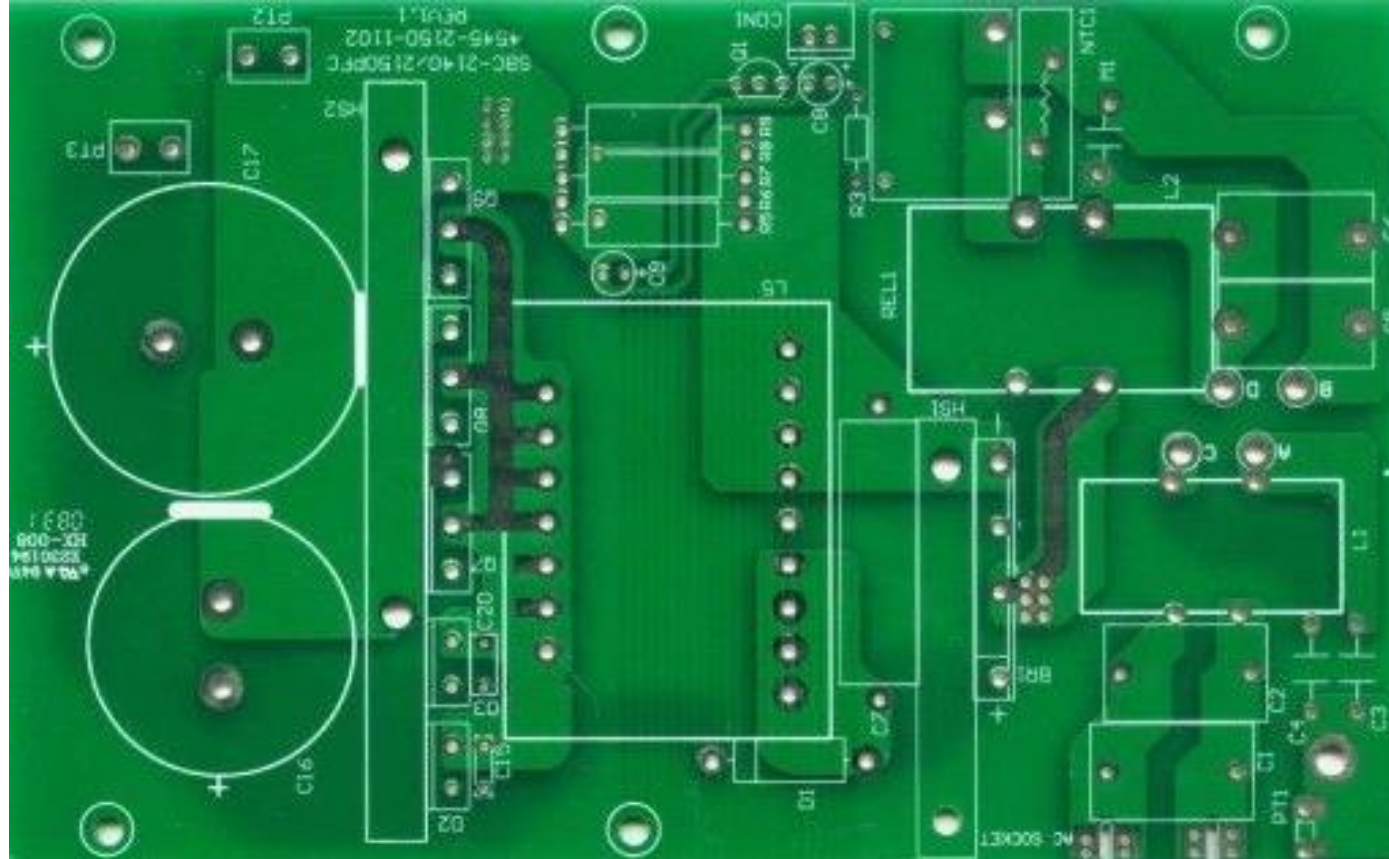
Types of PCB

- **Single-Sided PCBs**
- **Double-Sided PCBs**
- **Multilayer PCBs**
- **Rigid PCBs**
- **Flex PCBs**
- **Rigid-Flex PCBs**

Single Sided PCB



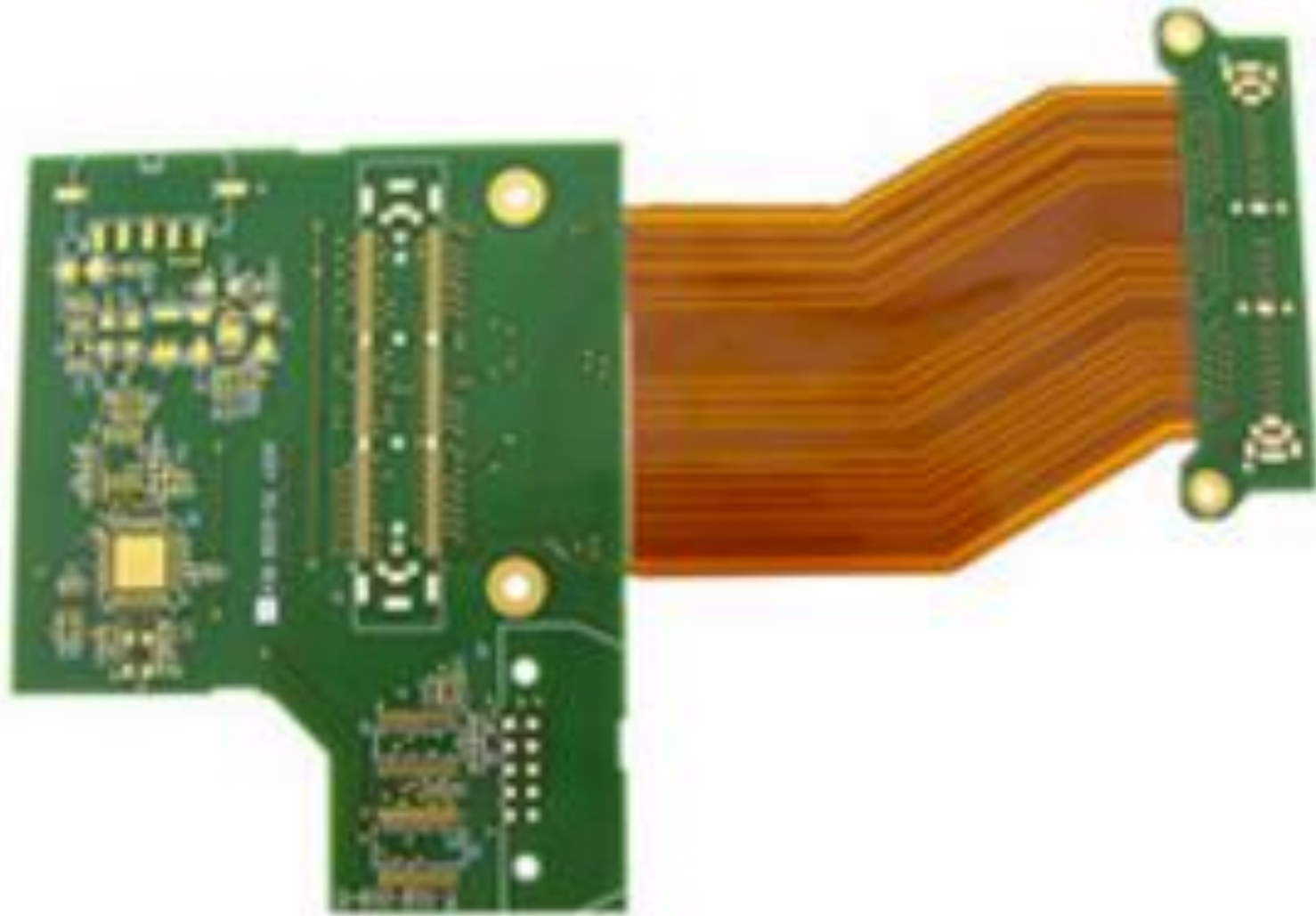
Double Sided PCB



Multi Layer



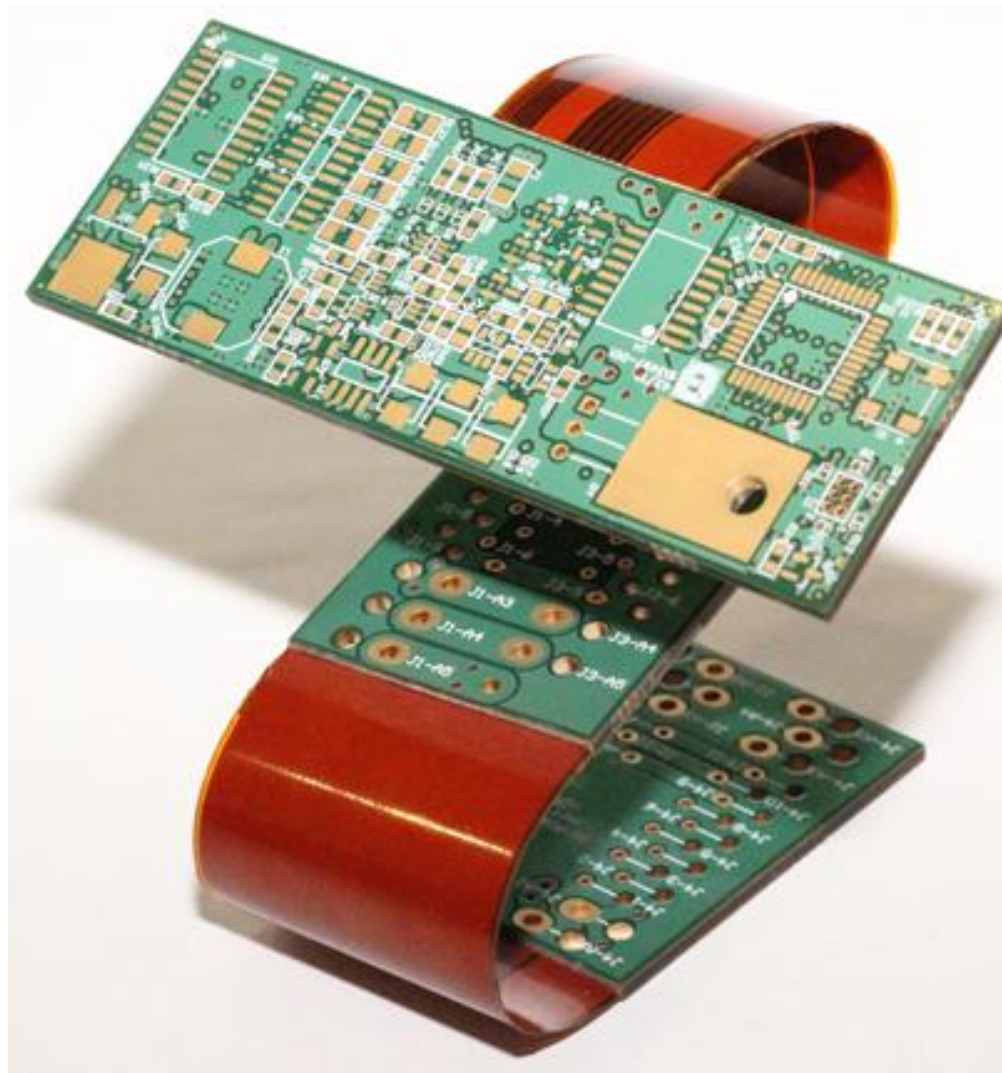
Rigid PCB



Flex PCB



Rigid-Flex PCB



Materials of PCB

- Conducting layers are typically made of thin copper foil.
- The board is typically coated with a solder mask that is green in color.
Other colors that are normally available are blue and red
- Unwanted copper is removed from the substrate after etching leaving only the desired copper traces or pathways

Parts of PCB

- ✓ Components
- ✓ Pads
- ✓ Traces
- ✓ Vias
- ✓ Top Metal Layer
- ✓ Bottom Metal Layer

Components

Components are the actual devices used in the circuit

This includes input/output connections

I/O ports, including power supply connections are also important in the PCB design.

Pads

Location that are components connect to

You will solder components to the pads on the PCB

Pads will connect to traces

Pads have an inner diameter and outer diameter

Vias

Pad with a plated hole connecting traces from one layer of board to other layers.

Attempt to minimize via use in your PCBs

Some component leads can be used as vias

Top Metal Layer

- ✓ Most of the components reside on the top layer
- ✓ Fewer traces on the top layer
- ✓ Components are soldered to the pads on the top layer of PCB
- ✓ Higher circuit densities

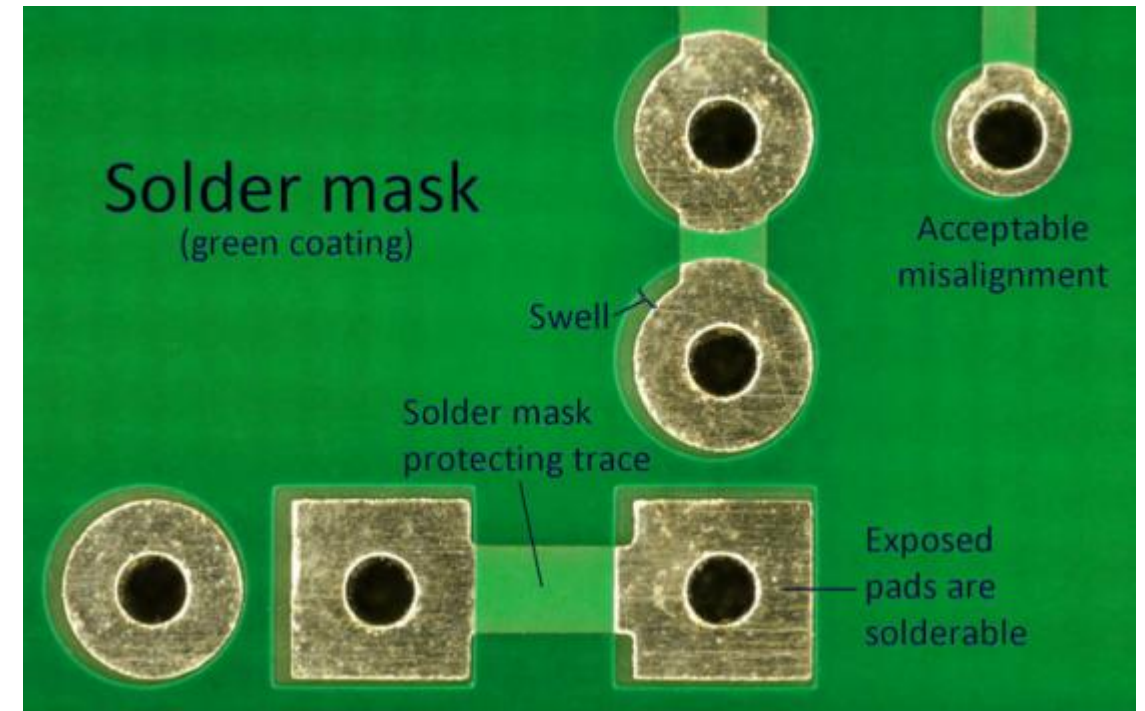


Bottom Metal Layer

- ✓ Few Components on this layer
- ✓ Many traces on the top layer
- ✓ Most soldering done on this layer

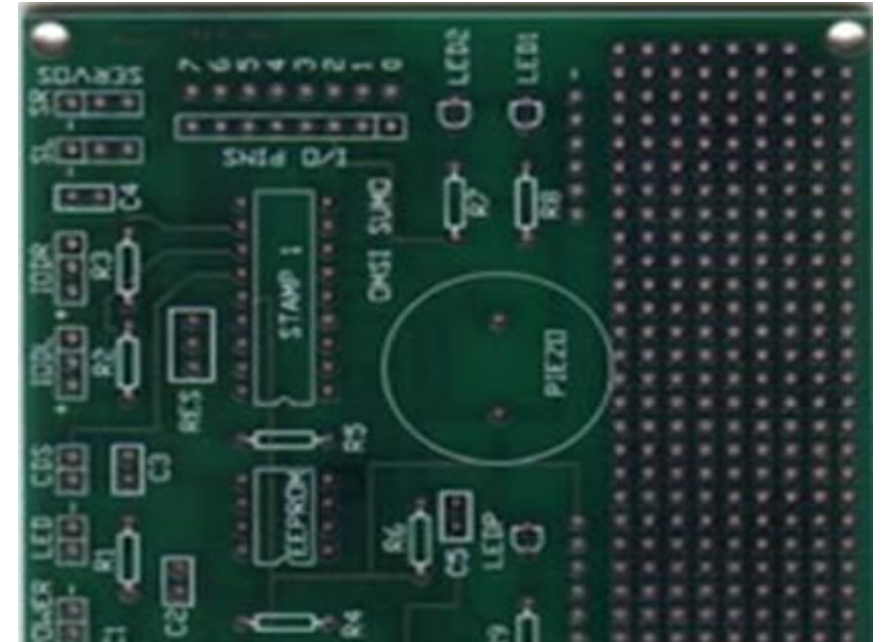
Solder Mask

- ✓ Protect copper traces on outer layers from corrosion
- ✓ Areas that shouldn't be soldered may be covered with polymer resist solder mask coating
- ✓ Designed to keep solder only in certain areas
- ✓ Prevents solder from binding between conductors and thereby creating short circuits.



Silkscreen

- ✓ Printing on the solder mask to designate component locations
- ✓ Readable information about component part numbers and placement
- ✓ Helpful in assembling, testing and servicing the circuit board



Multilayer PCB

- ✓ More than top and bottom layer
- ✓ Typically there will be a power plane, ground plane, top layer, and bottom layer.
- ✓ Sometimes signal layers are added as needed.
- ✓ Sometimes RF planes made of more expensive materials are added.

Physical Design Issues

- ✓ Components Size
- ✓ Heat Dissipation
- ✓ Input and Output
- ✓ Mounting Points

Components Size*

- ✓ Make sure components will actually fit.
- ✓ This especially applies for circuits that component densities
- ✓ Some components come in multiple sizes. SMT vs Through Hole
- ✓ Sometimes you can get tall and narrow caps or short and wide capacitors.

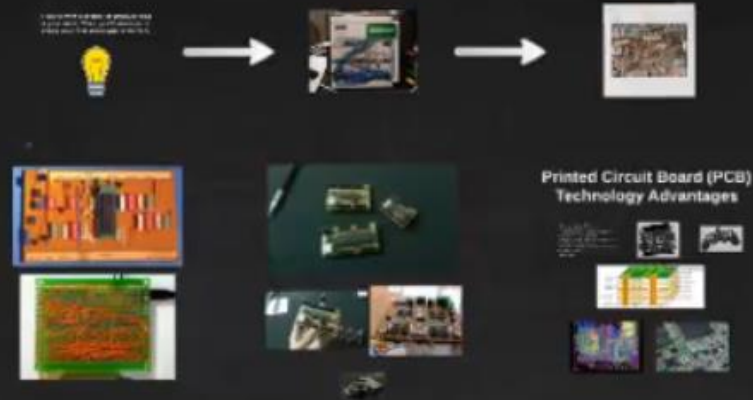
Mounting Points

- ✓ The PCB needs to be mechanically secured to something.
- ✓ Could be the chassis-consist of metal frame on which the circuit boards and other electronic components are mounted
- ✓ Could be another PCB/socket on PCB
- ✓ Could be attachments to a heatsink

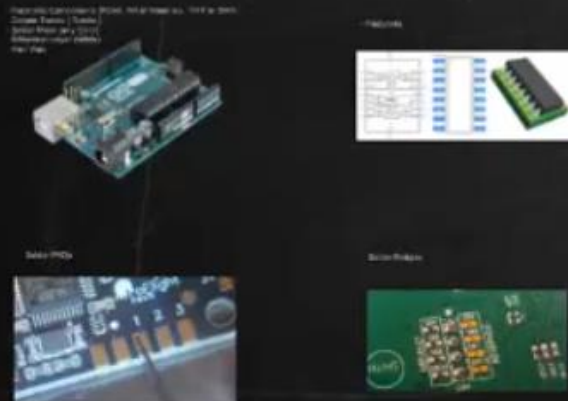
Pre-Work*

- ✓ Thoroughly simulate your circuit-make sure circuit worked in simulations
- ✓ Thoroughly test the prototype-make sure the circuit worked on the bread board
- ✓ Have all the data sheets handy for every components
- ✓ Play around with the placement of components.

Why Do We Need PCBs?



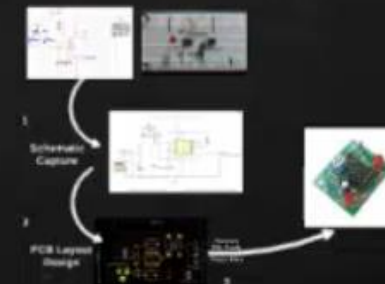
Elements of a PCB



CAD Tools For PCB Design

CAD: Computer Aided Design

The Main Functionality of PCB CAD Design Tools



The Most Common CAD PCB Design Tools

Paid:



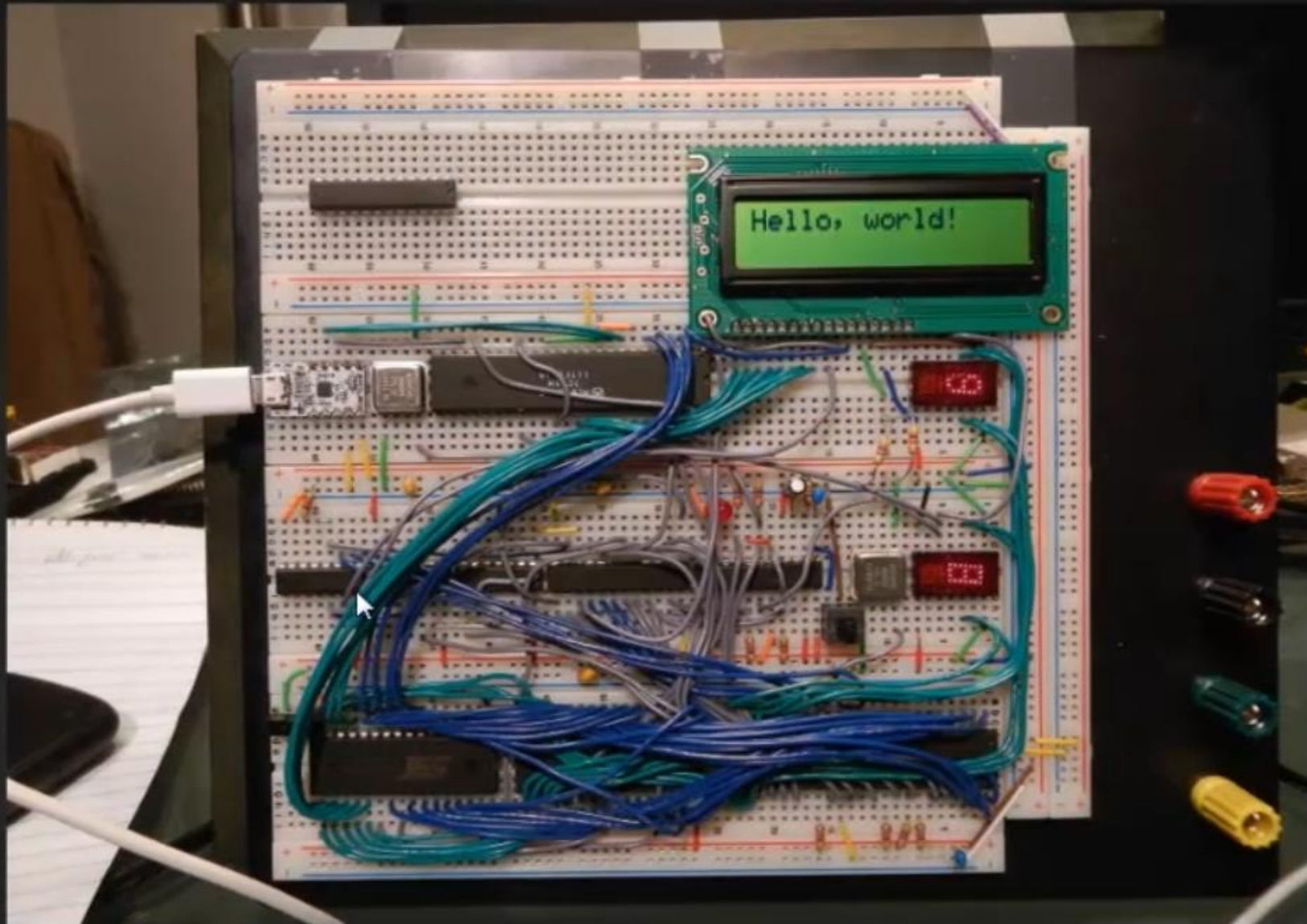
and others...

Free:



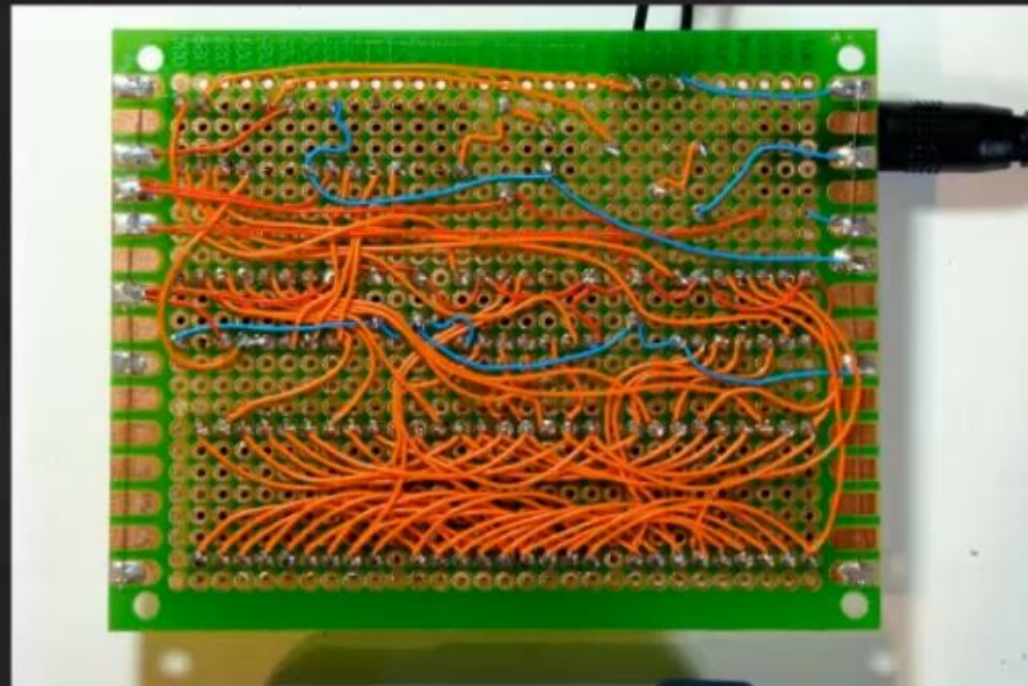
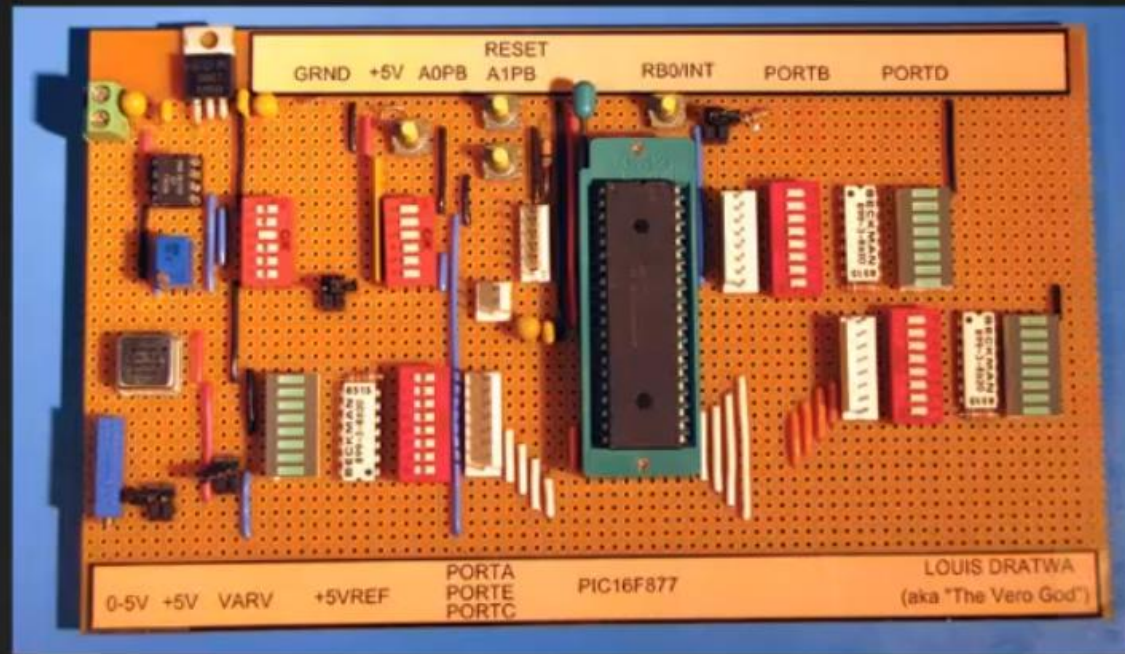
it starts with a project or product idea
in your mind. Then, you'll move on to
create your first prototype to verify it.

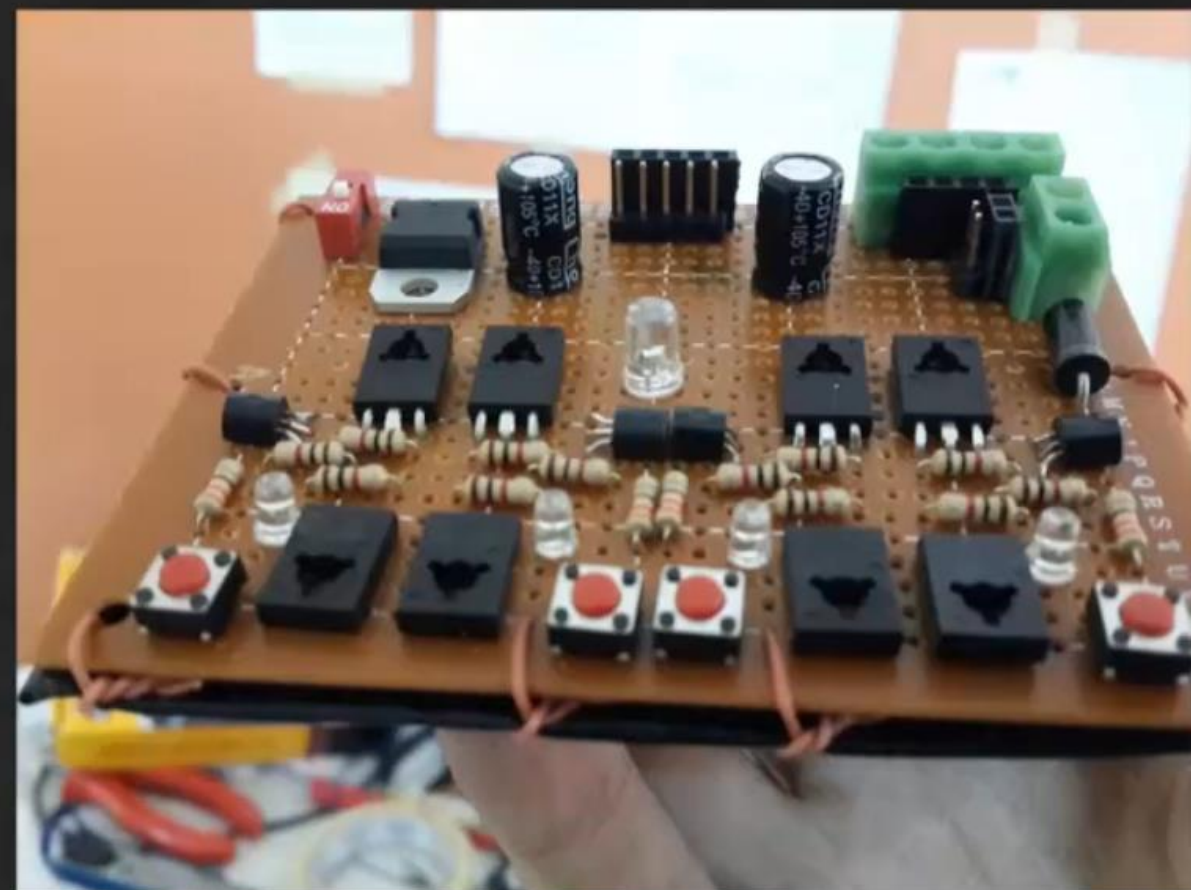


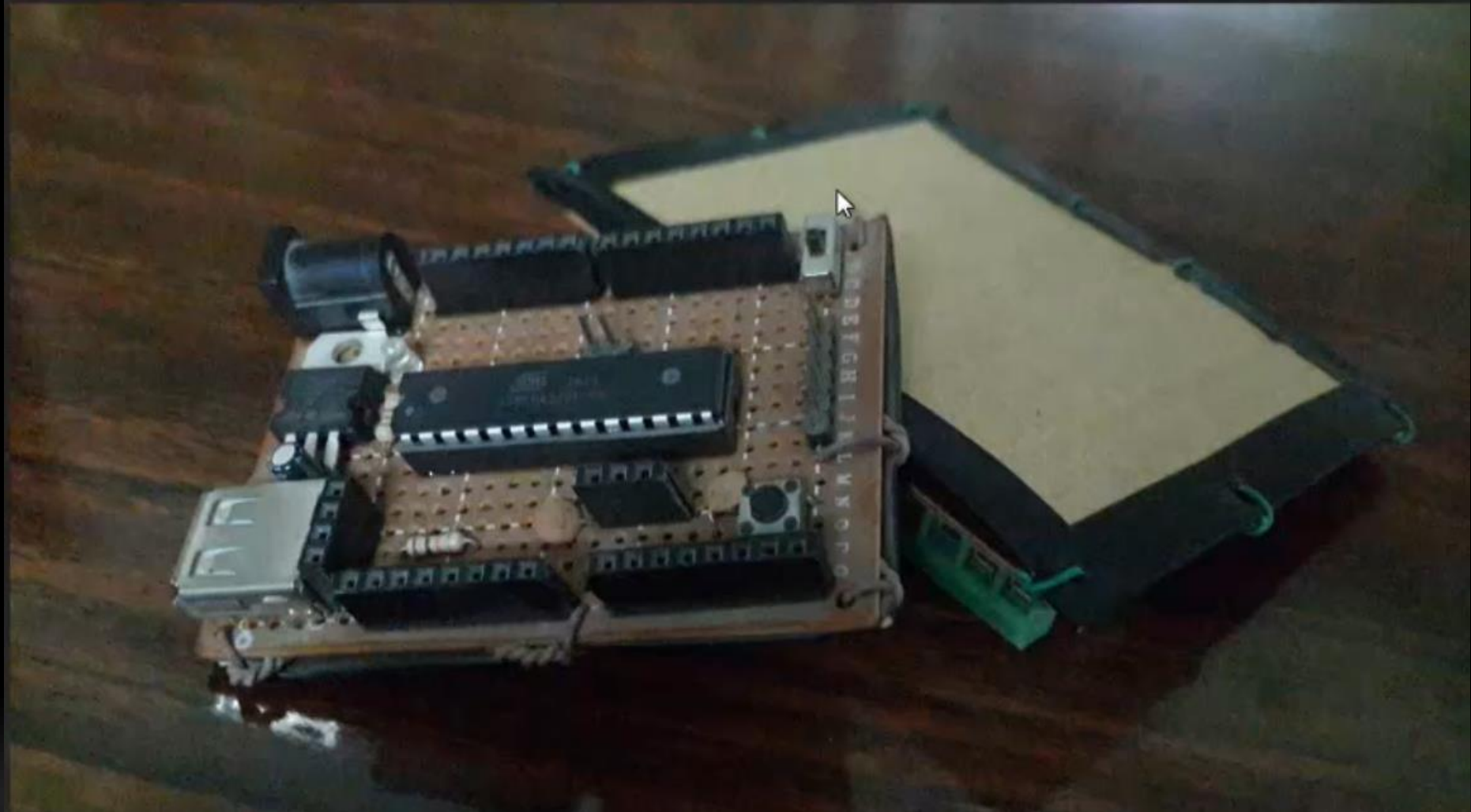


1. Hard To Manufacture
2. Hard To Maintain
3. Hard To Upgrade
4. Extremely Labor Intensive



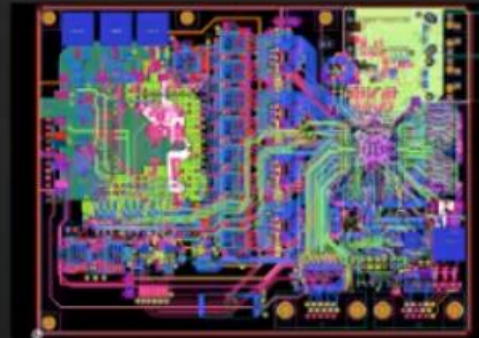
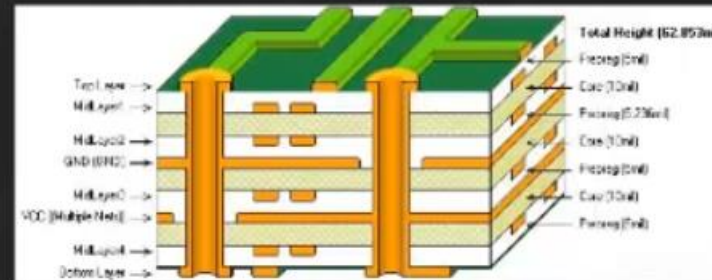
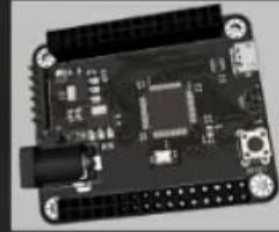






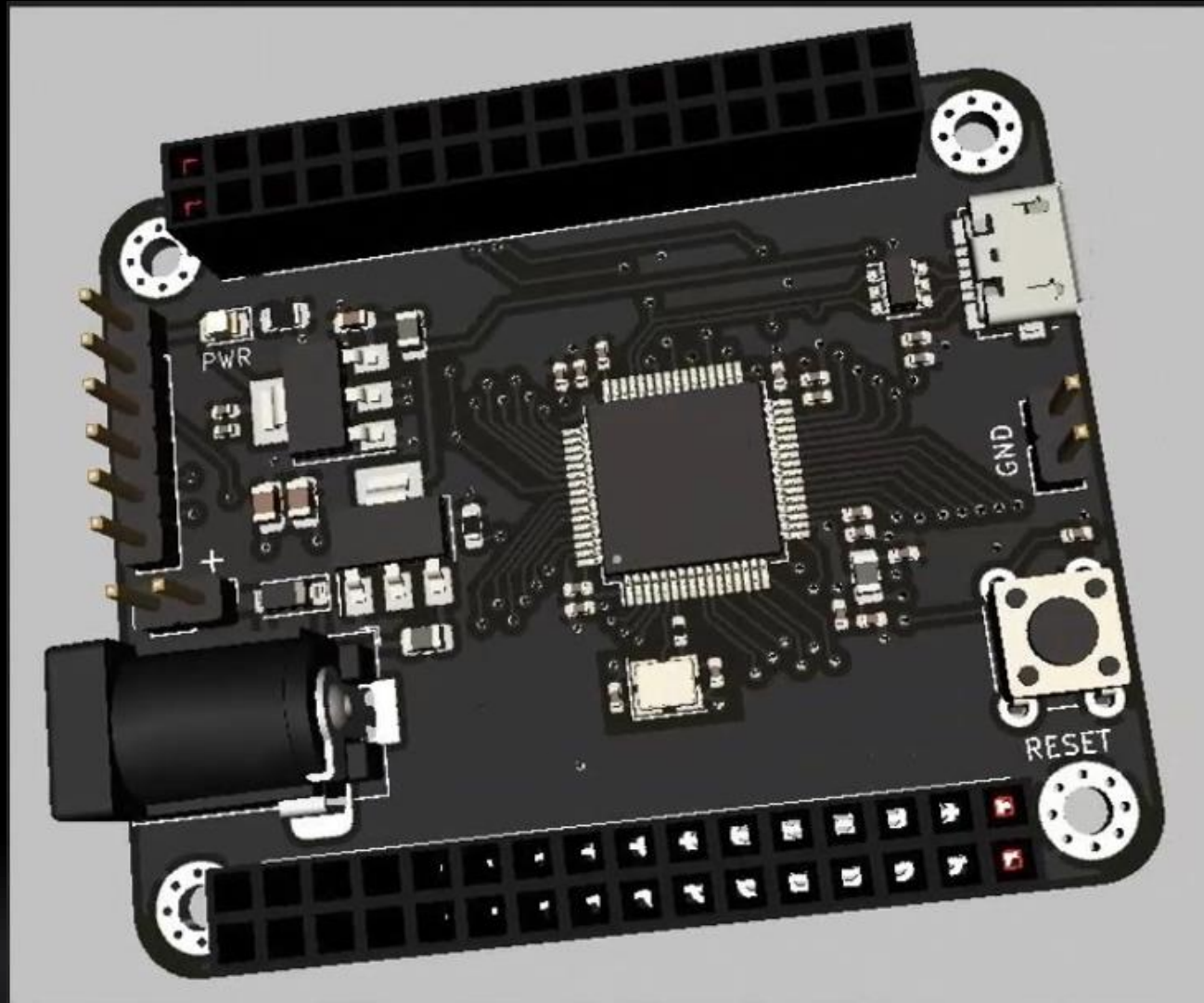
Printed Circuit Board (PCB) Technology Advantages

- Saves Too Much Space
- Very Quick To Manufacture
- Components Can Be Assembled With PnP Machines (Automated)
- You Can Deliver Dozens of Products To Meet The Market's Needs
- Much Easier To Develop/Upgrade and to Maintain As Well
- And more...

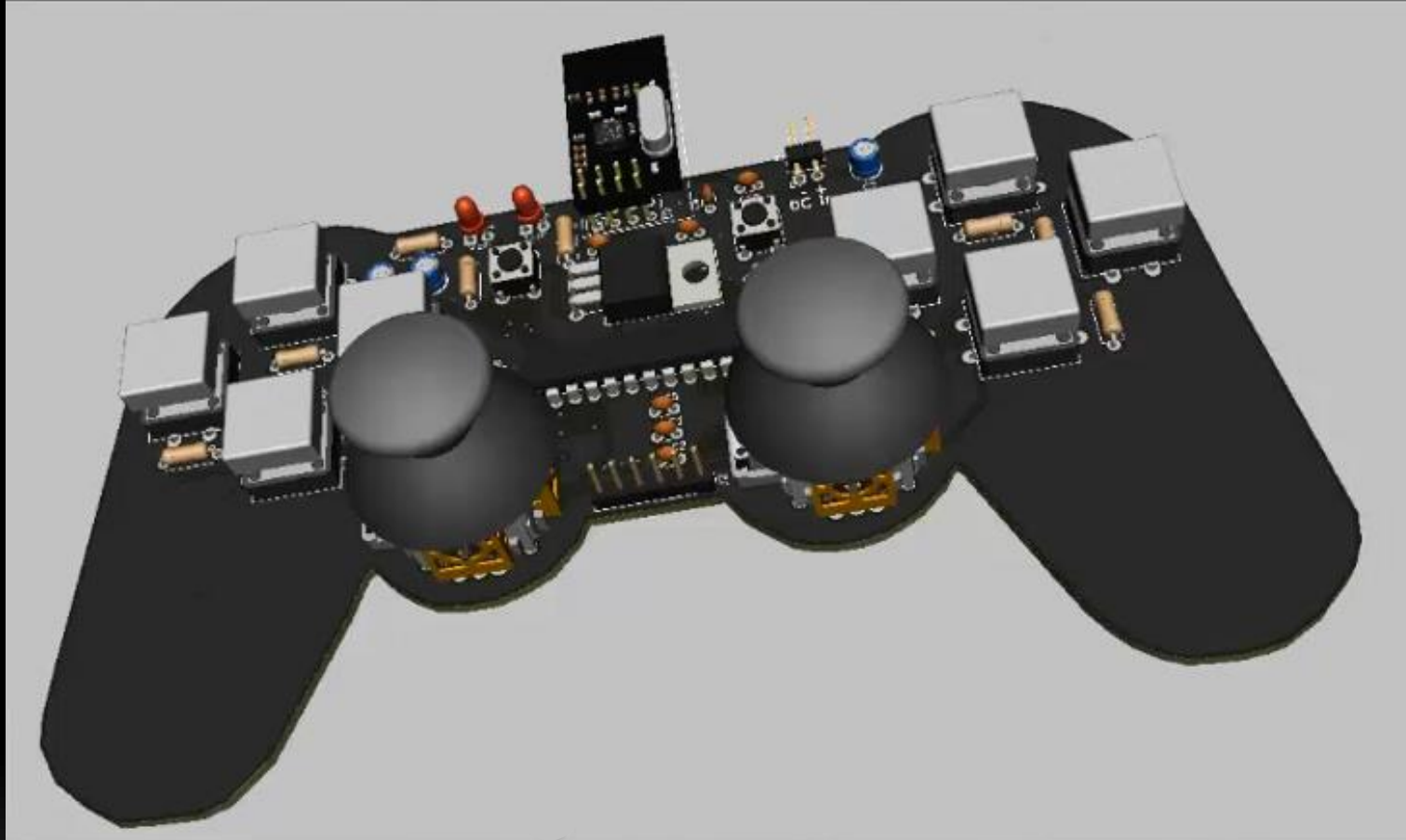


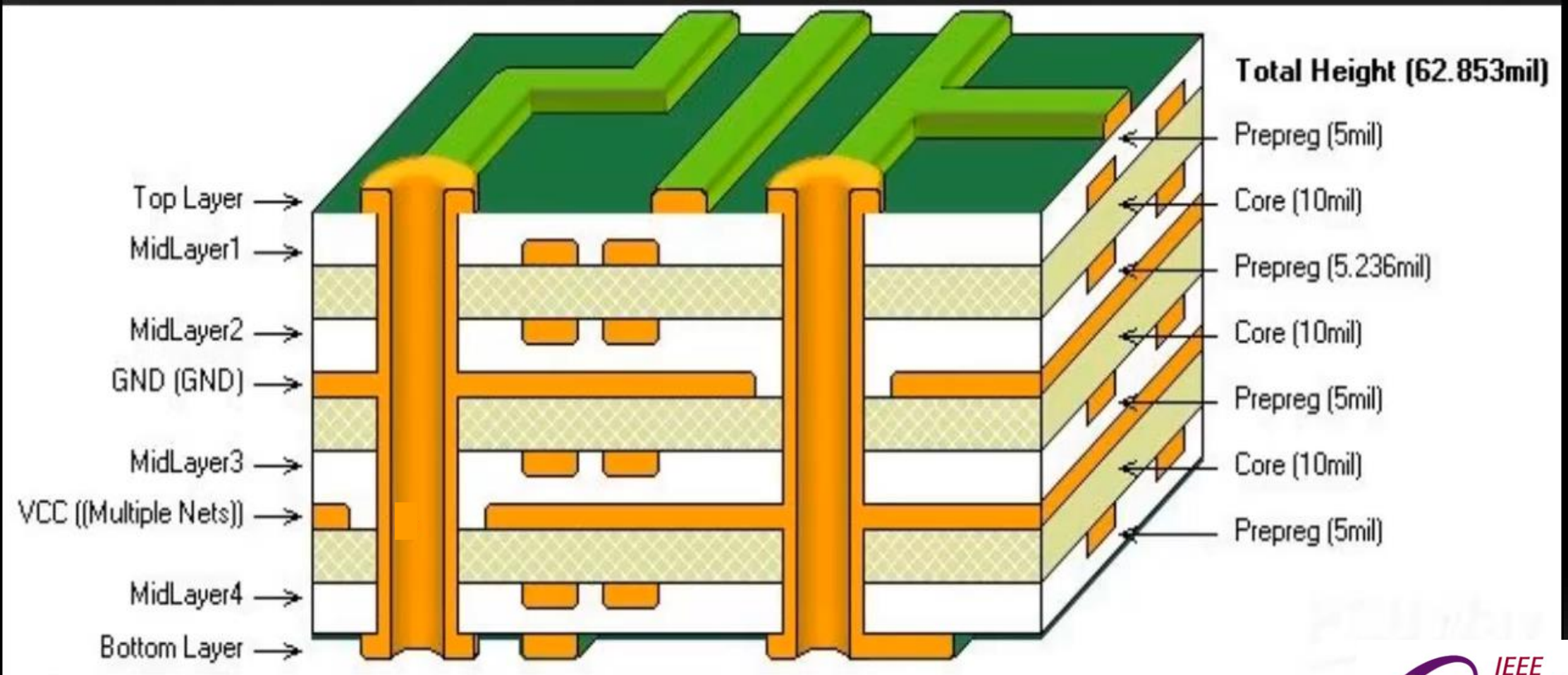
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- And more..

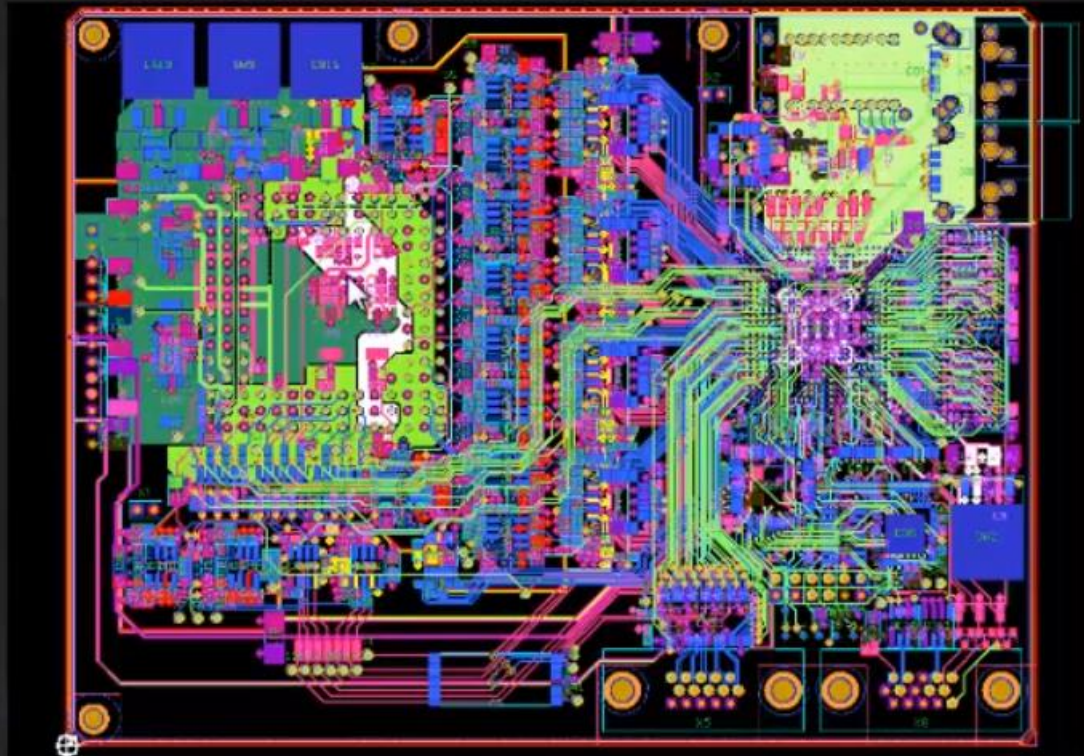
Multilayer



Edge cuts Layer





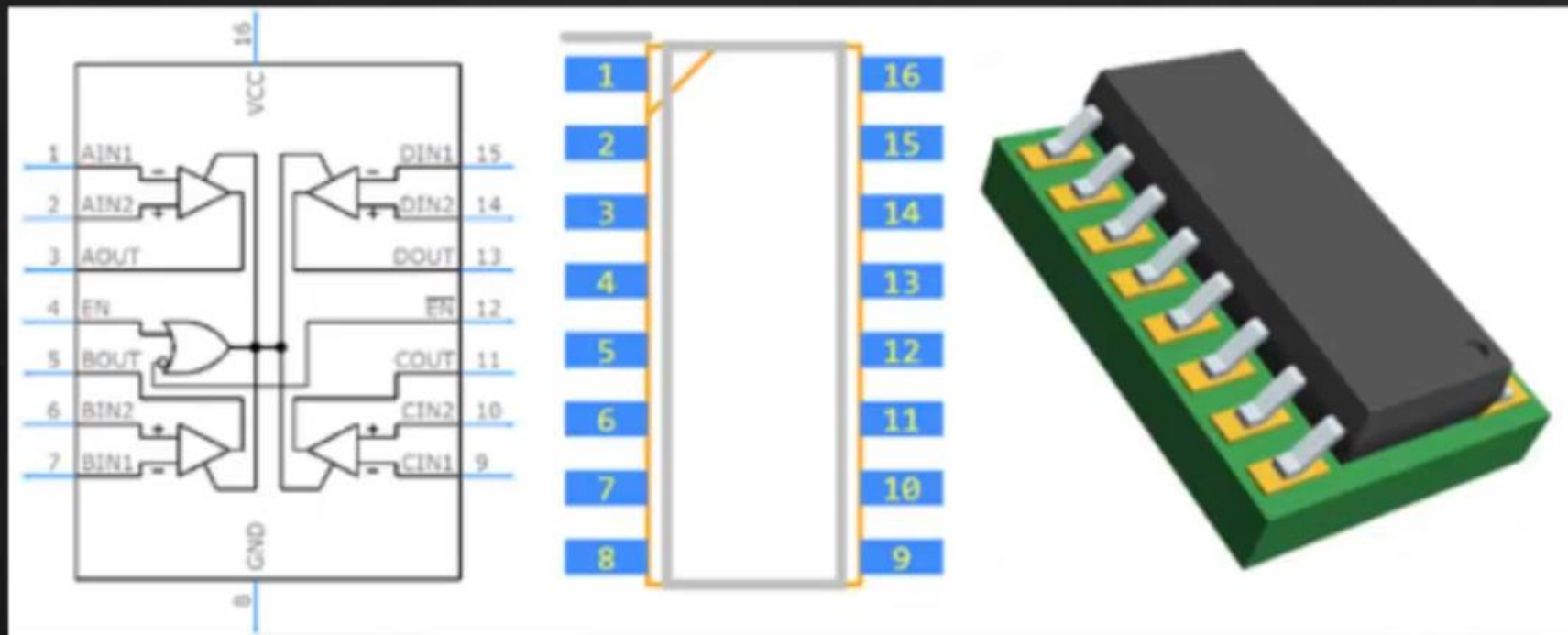


Elements of PCB

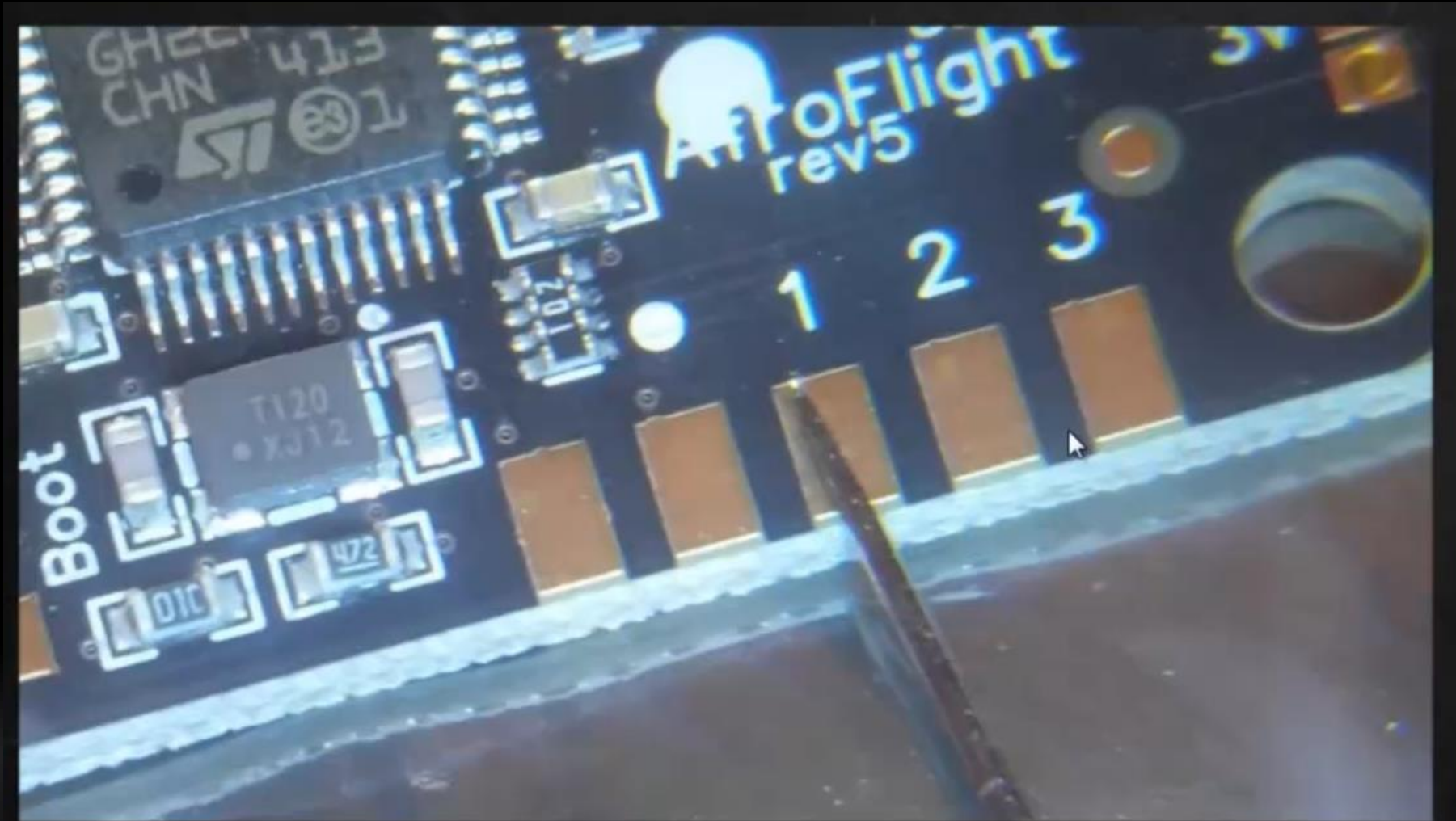
- Electronic Components (BOM), Bill of Materials. "THT or SMD".
- Copper Traces (Tracks).
- Solder Mask (any Color).
- Silkscreen Layer (White).
- Via / Vias.



.Footprints

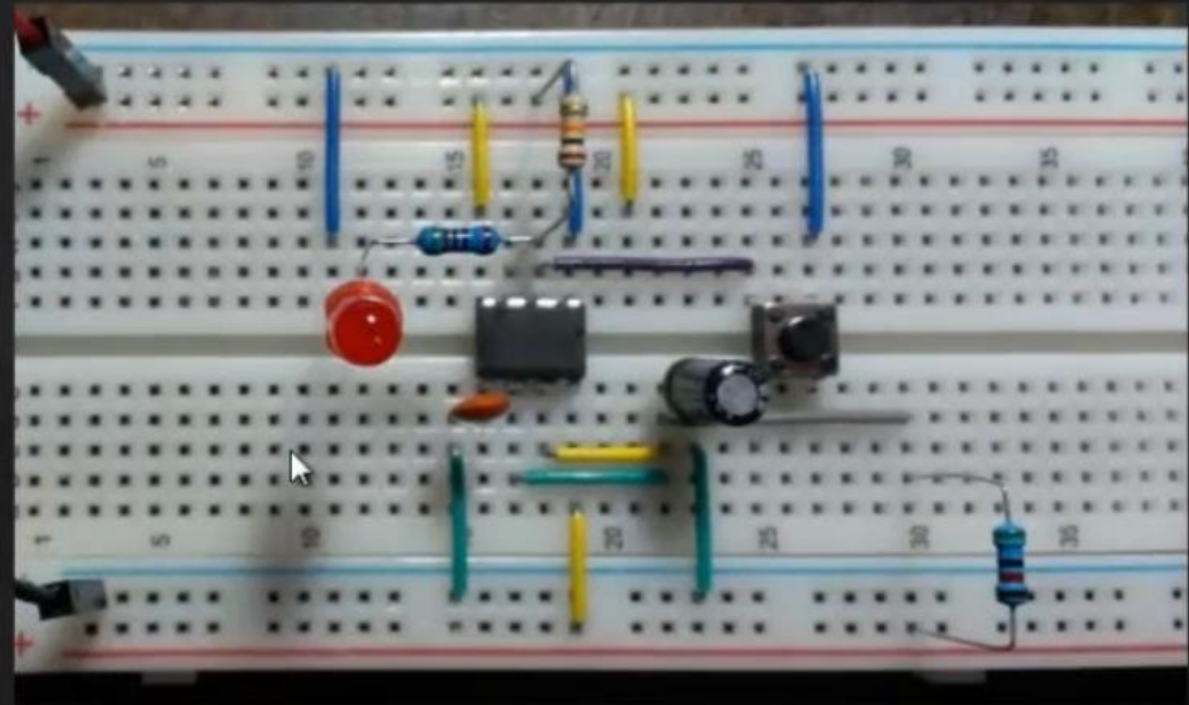
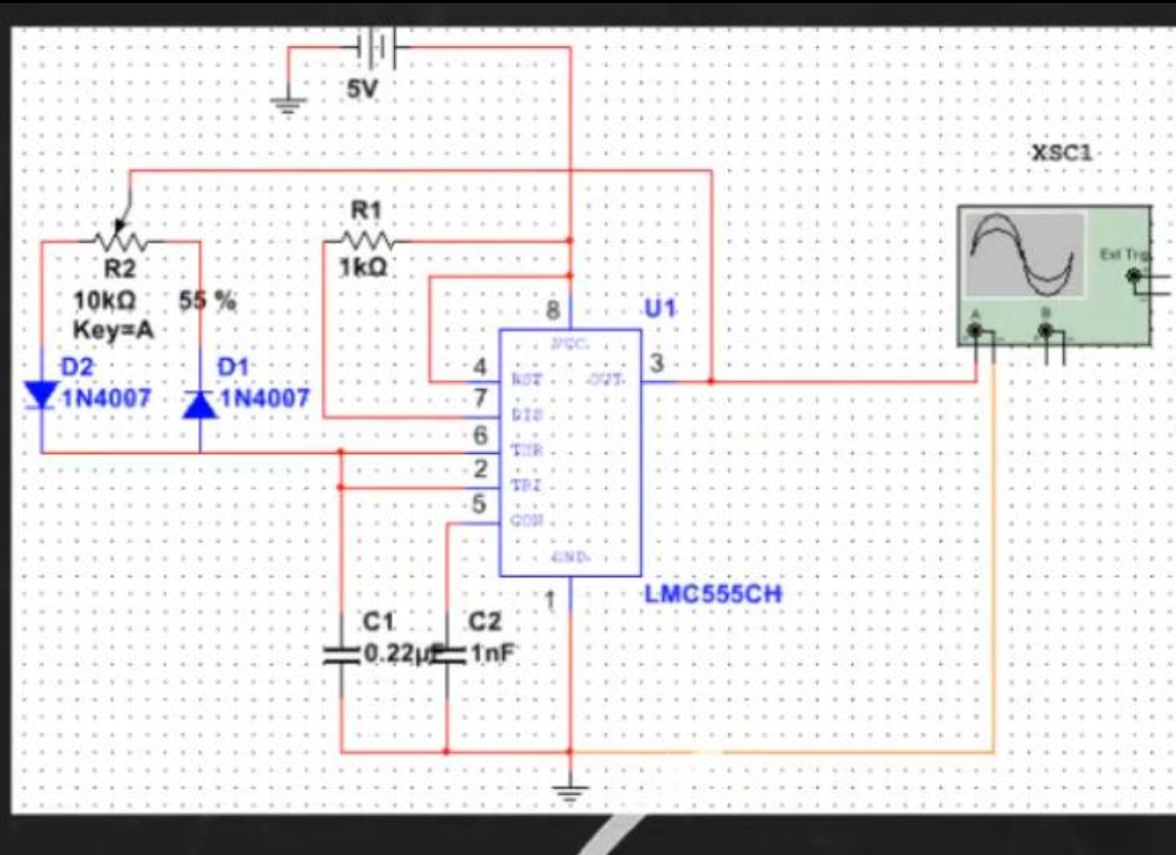


.Solder pad



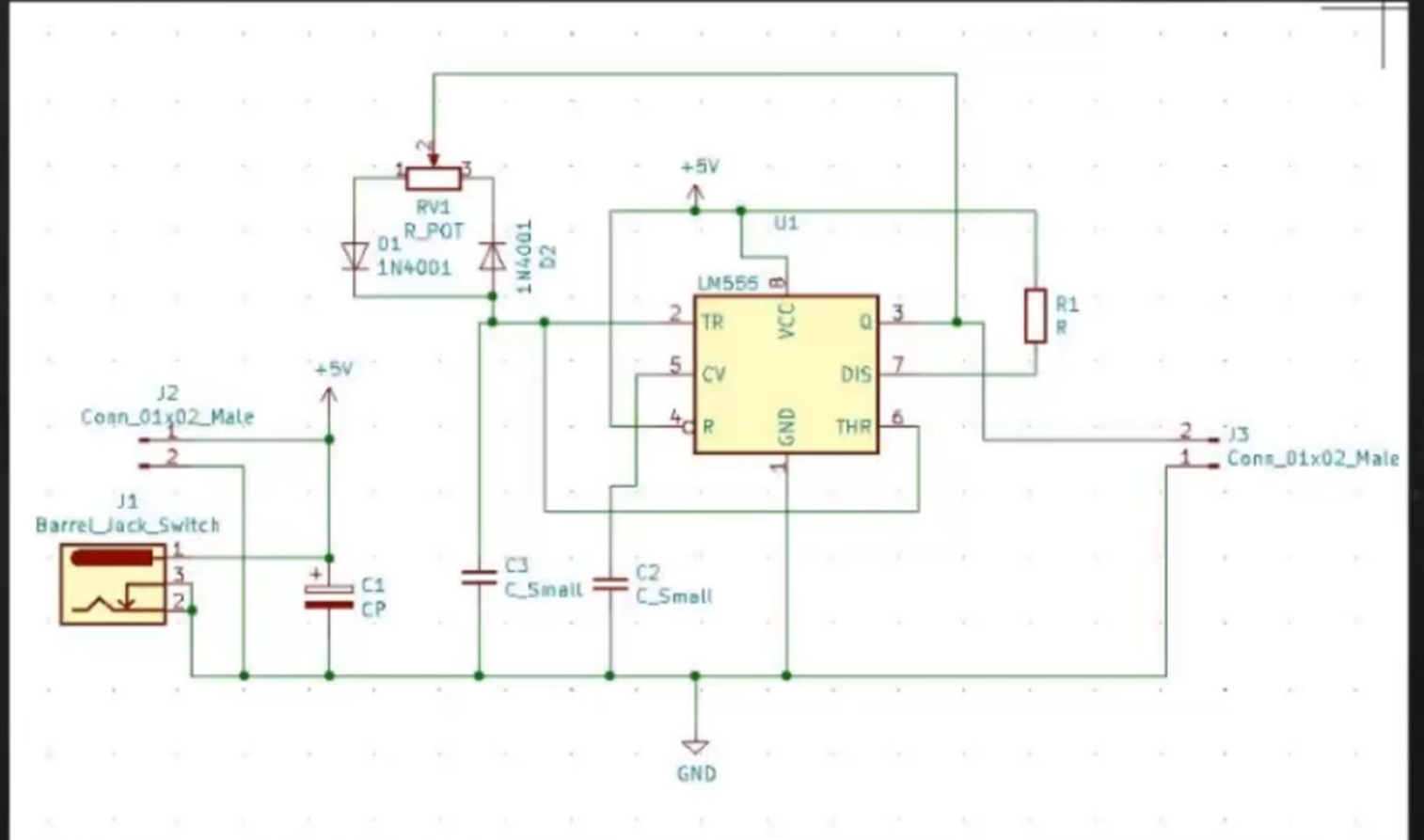
CAD Tools for PCB Design

1. Schematic Capture



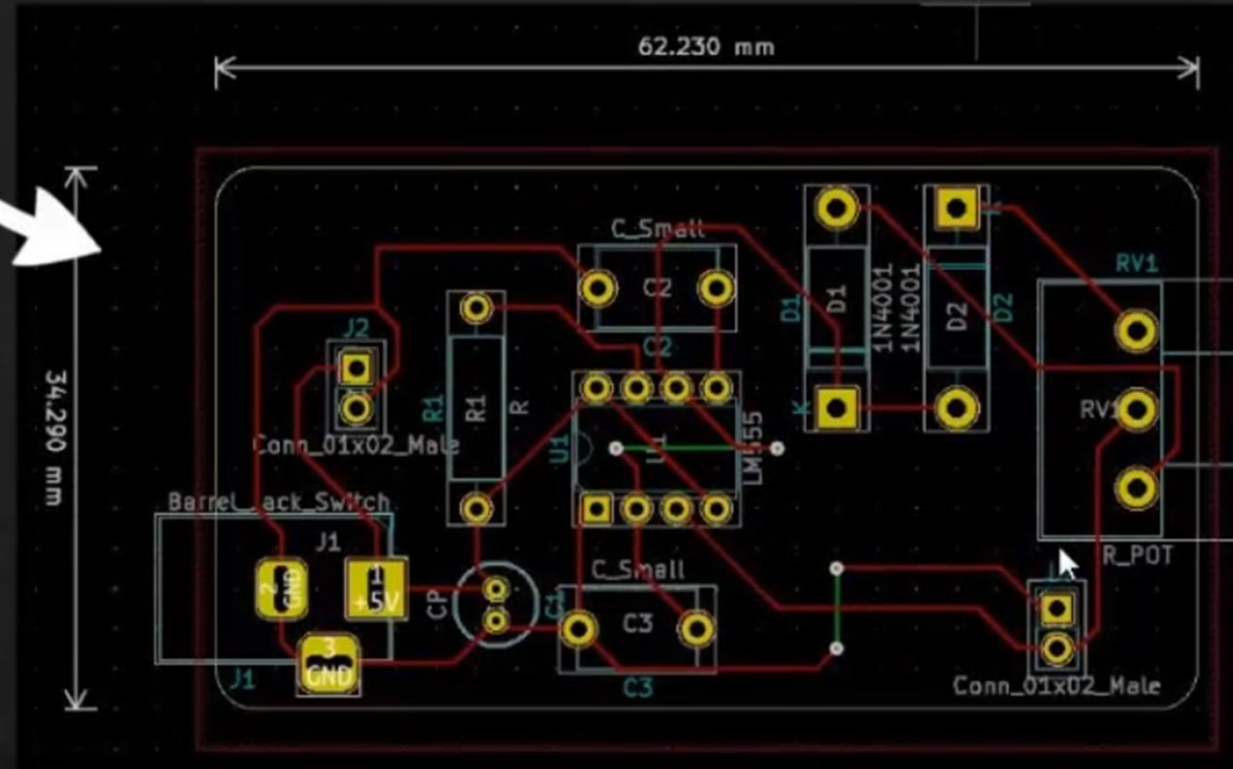
1

Schematic Capture



2

PCB Layout Design



Generate
Fab.-Ready
Output Files

3



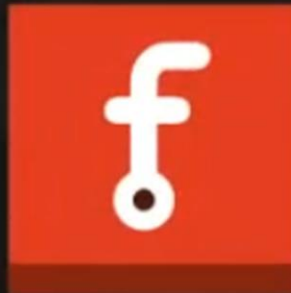
The Most Common CAD PCB Design Tools

Paid:



and others...

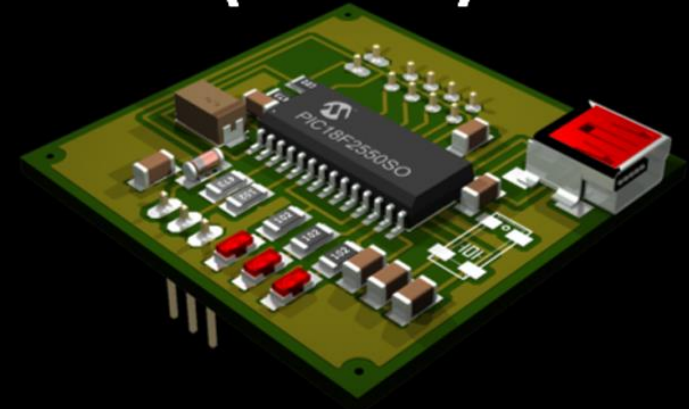
Free:



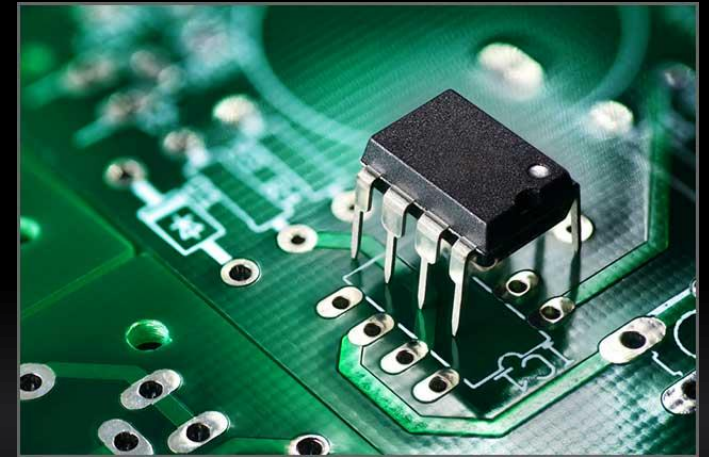
THT and SMD/SMT

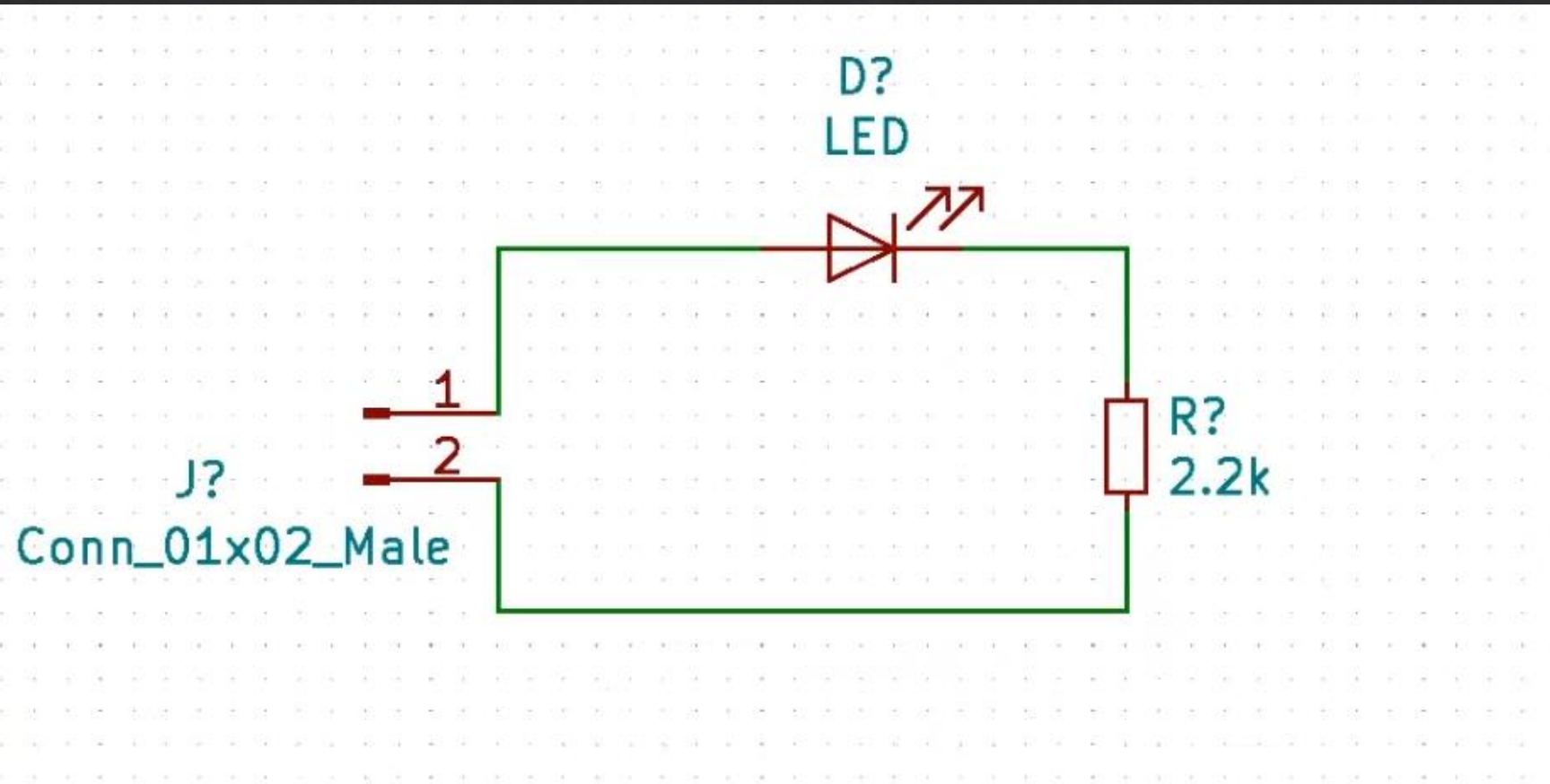
THT- Through Hole Technology

(SMD)



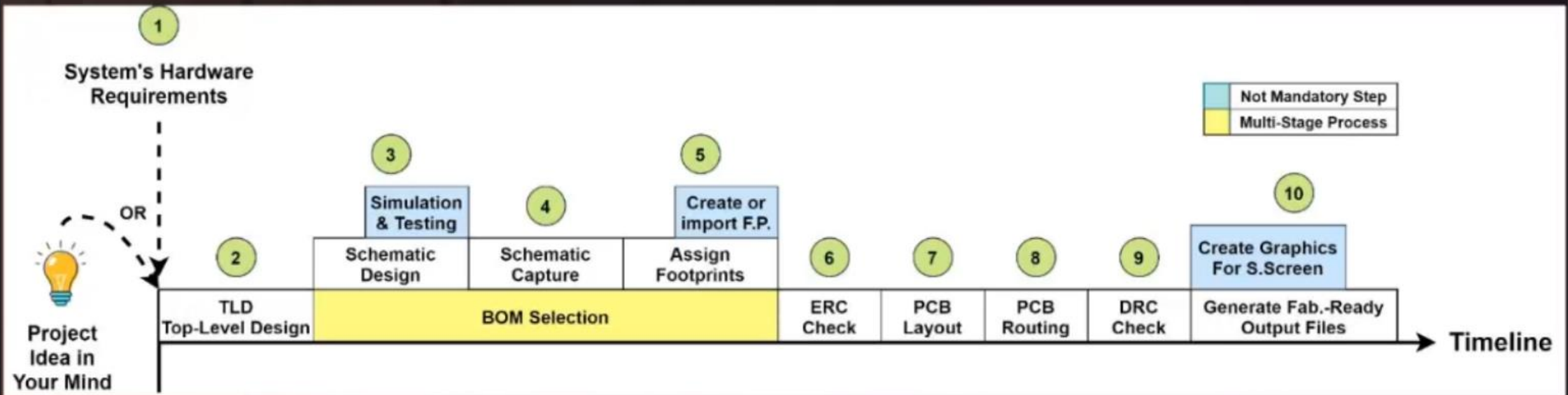
SMD/SMT- Surface Mounted Device/Technology

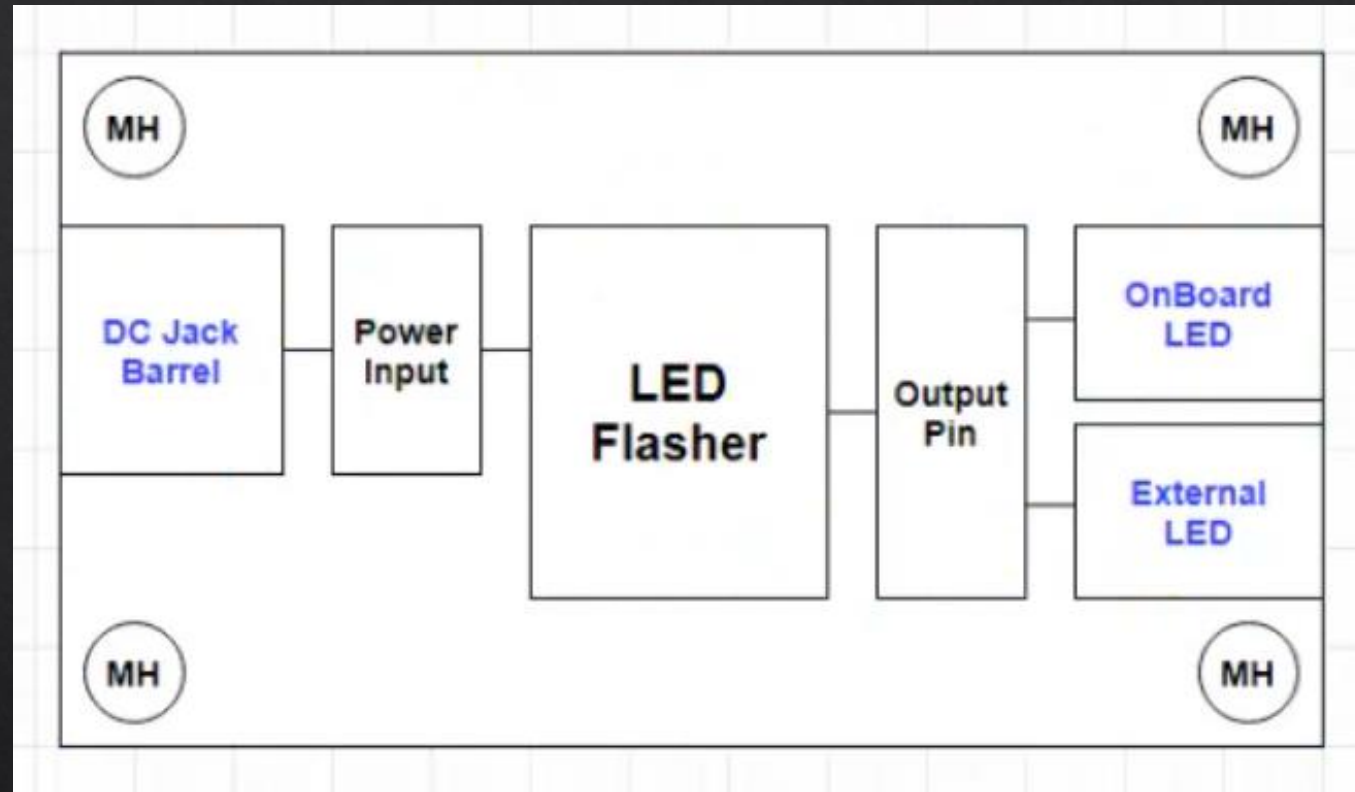




PCB Design Methodology

The way I approach hardware (PCB) design projects



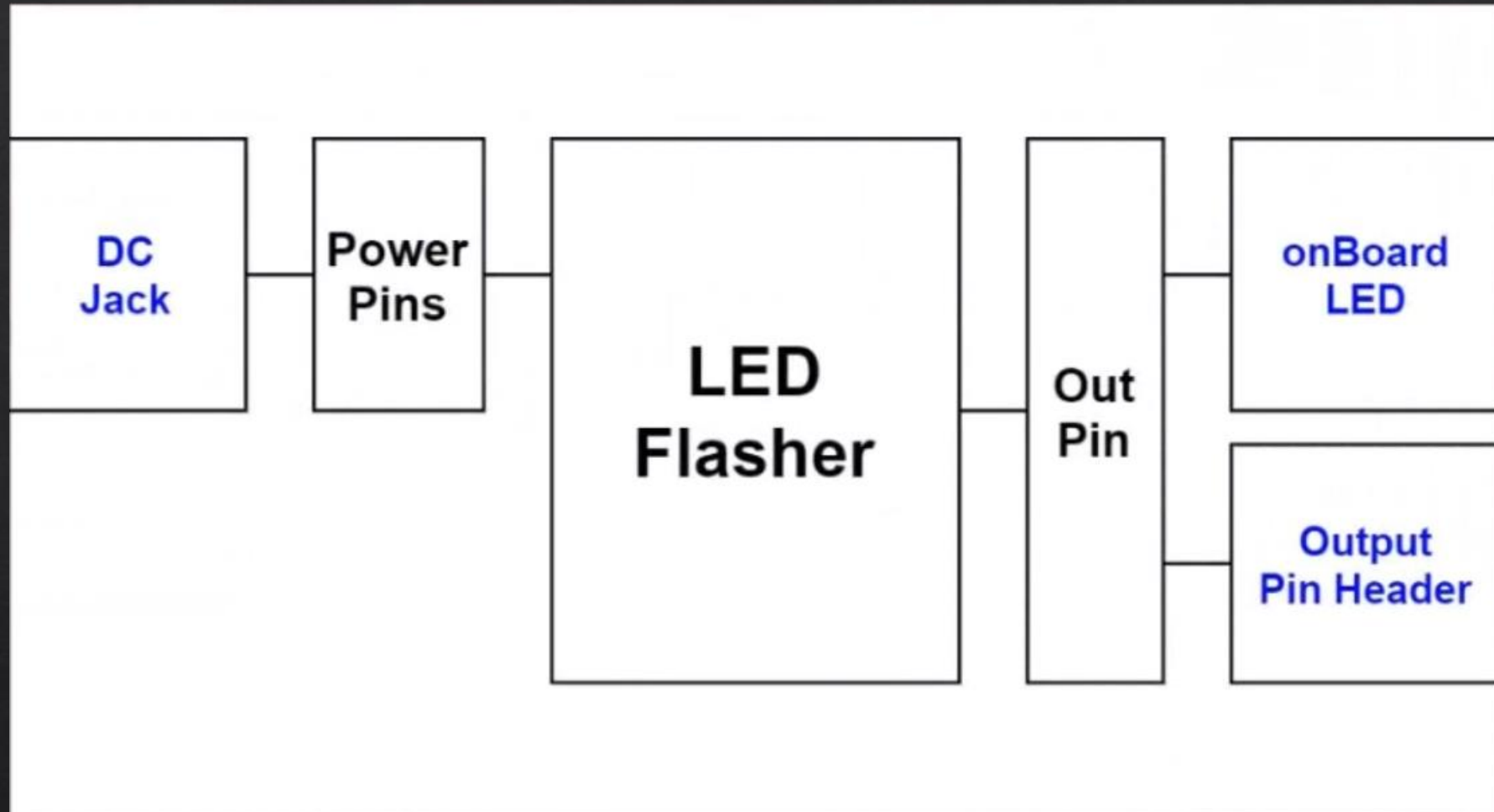


Pre-Design Stage

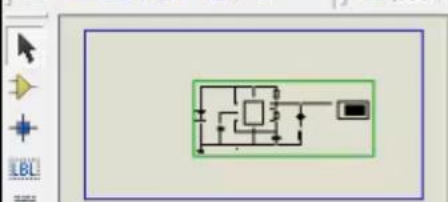
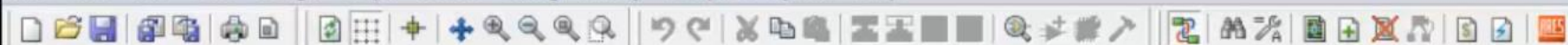
PCB Project1 Hardware Requirements (LED Flasher)

- Inputs:
 - NA
- Outputs:
 - Small LED (On Board)
 - Small LED (Off-Board) "Solder PADs or Screw Terminal"
- In/Out:
 - NA
- Power:
 - DC 5-12v From Adapter with Barrel Jack
- PCB Size or Dimensions:
 - NA
- Functionality Description:
 - The PCB **shall** Blink an LED once a second always after power-up.
- Other Notes For The Designer:
 - Add Open-Source Graphics to The Silkscreen Layer
 - Add Project's Name "LED Flasher" to The Silkscreen
 - Add 4 Mounting Holes (M2 size)

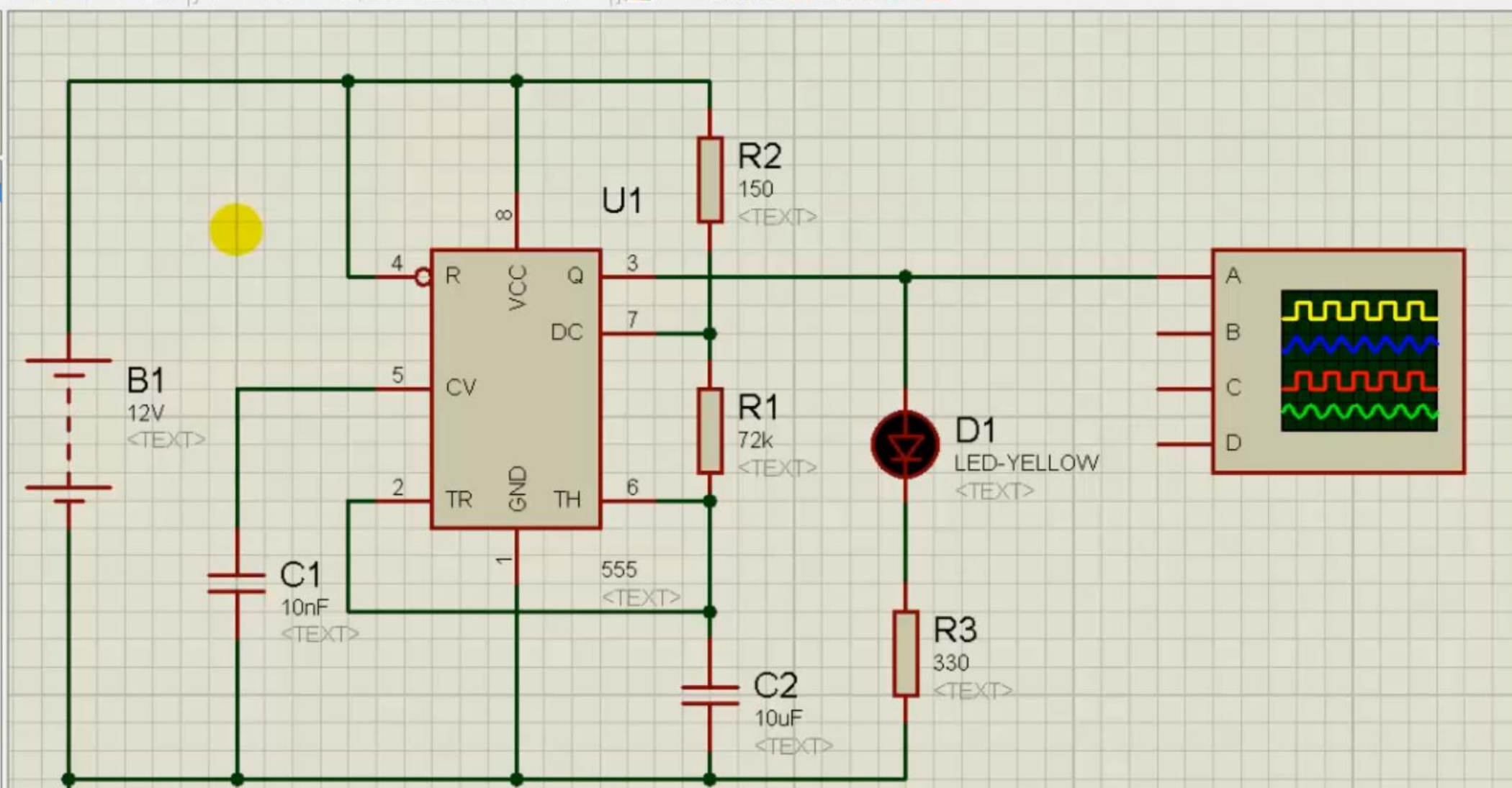
Pre-Design Stage

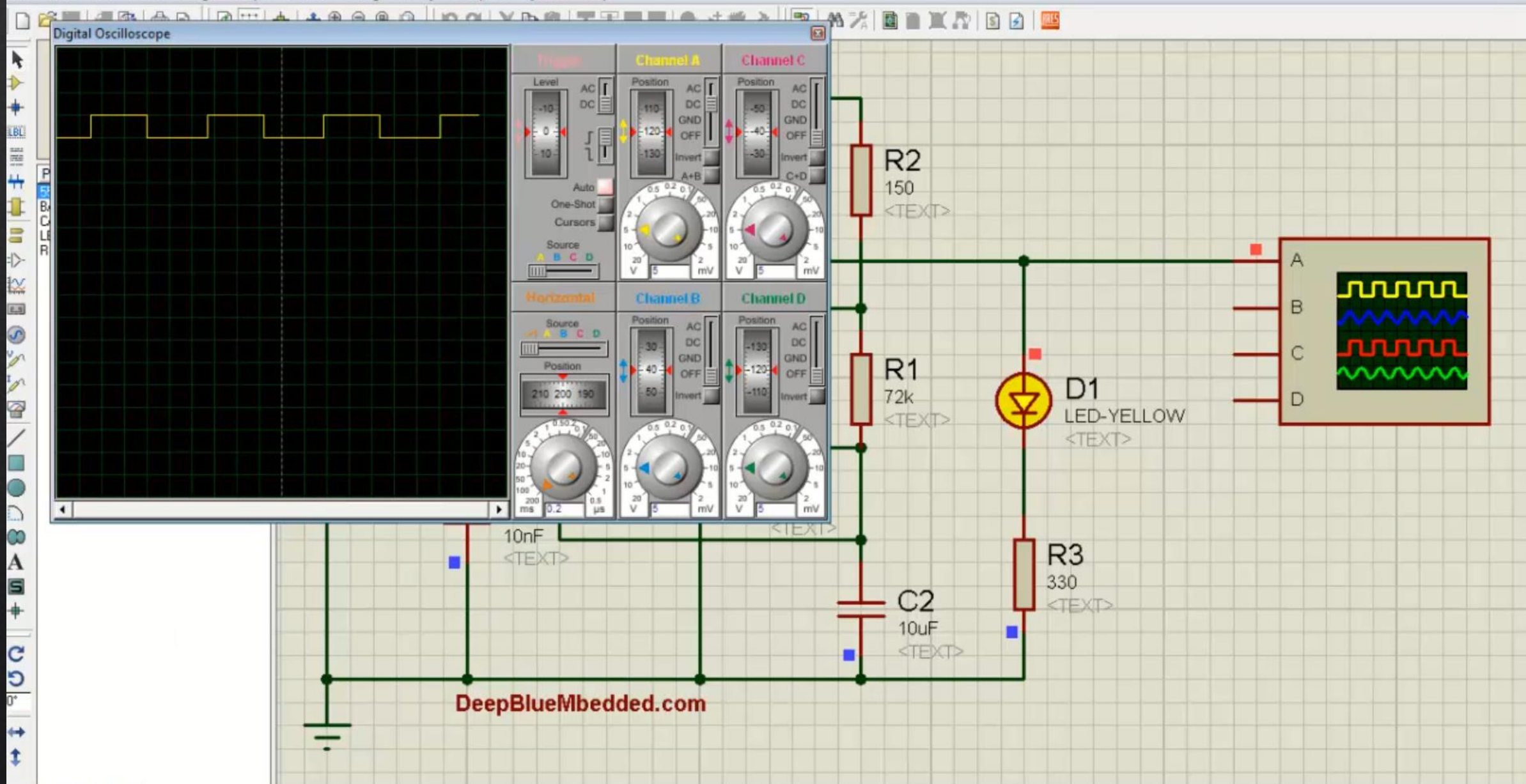


File View Edit Tools Design Graph Source Debug Library Template System Help

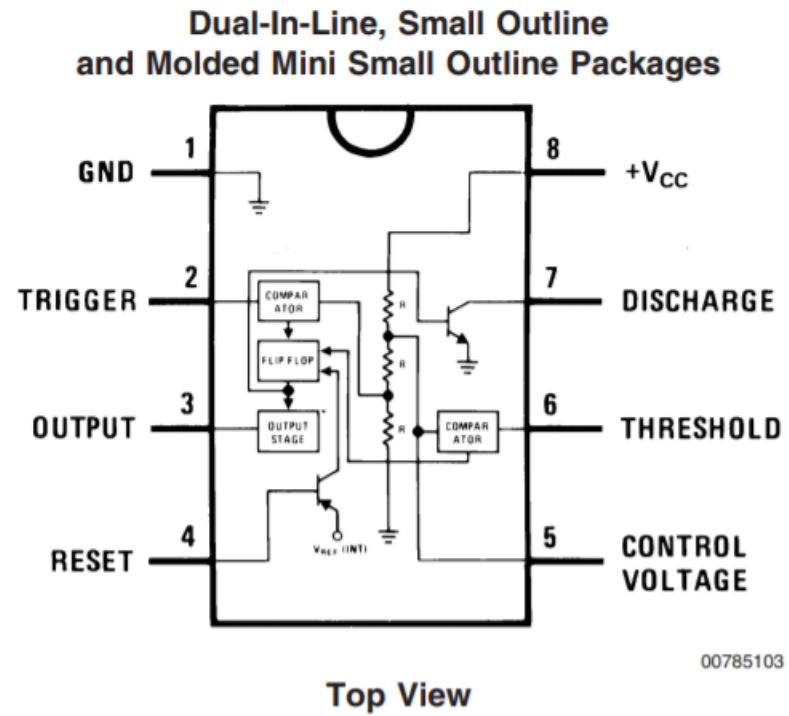


P L DEVICES
555
BATTERY
CAP
LED-YELLOW
RES



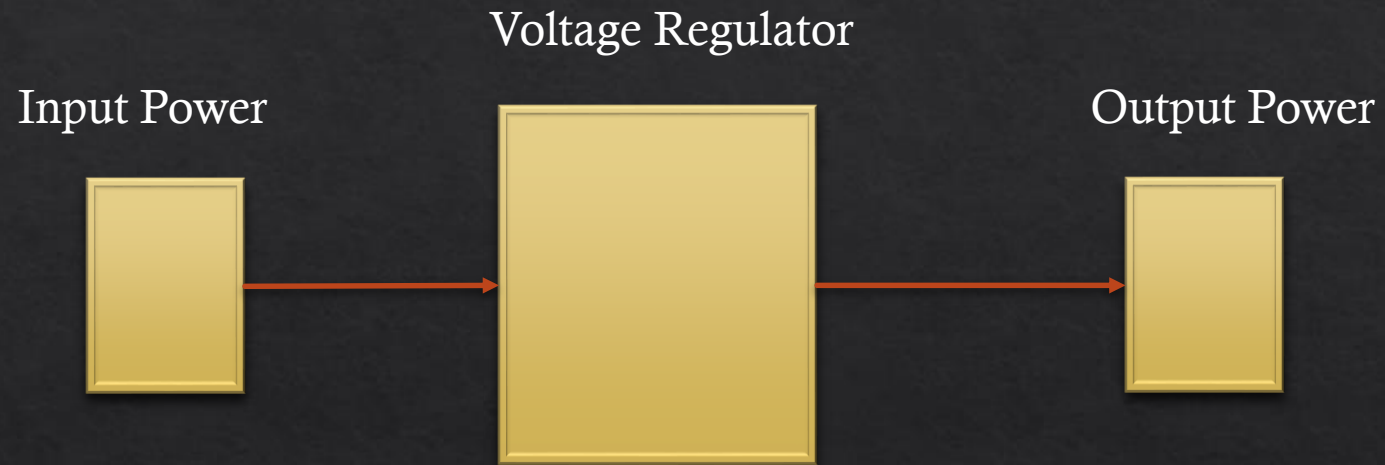


Connection Diagram



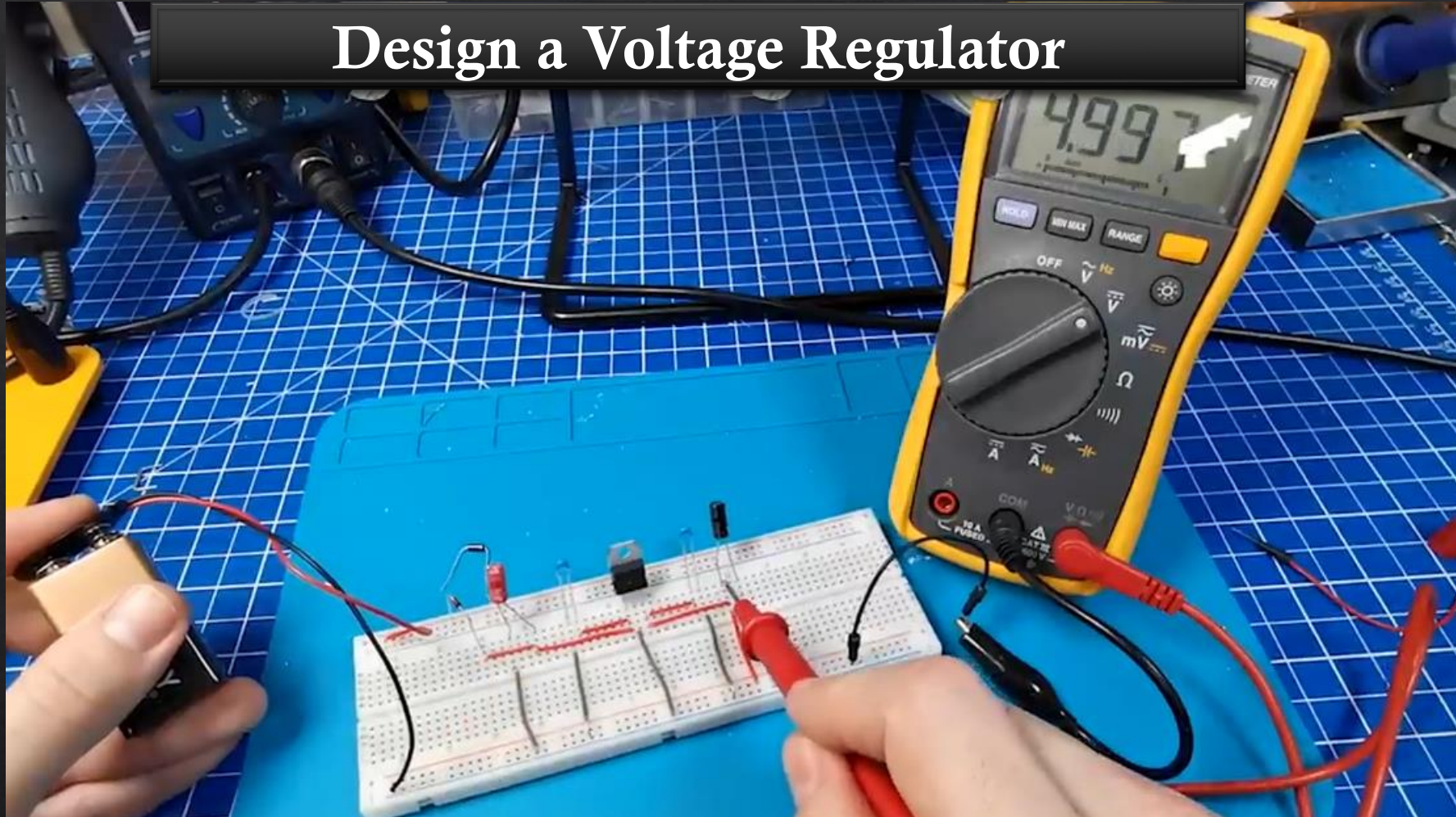


Project 3

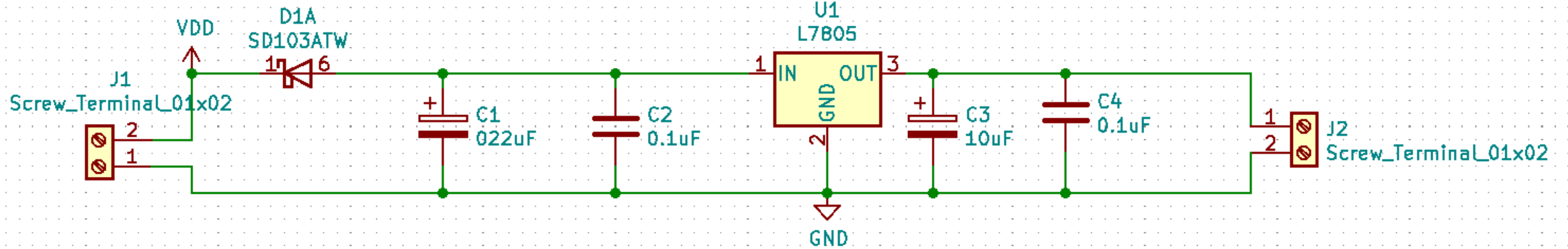


Project 3

Design a Voltage Regulator



Schematic Capture



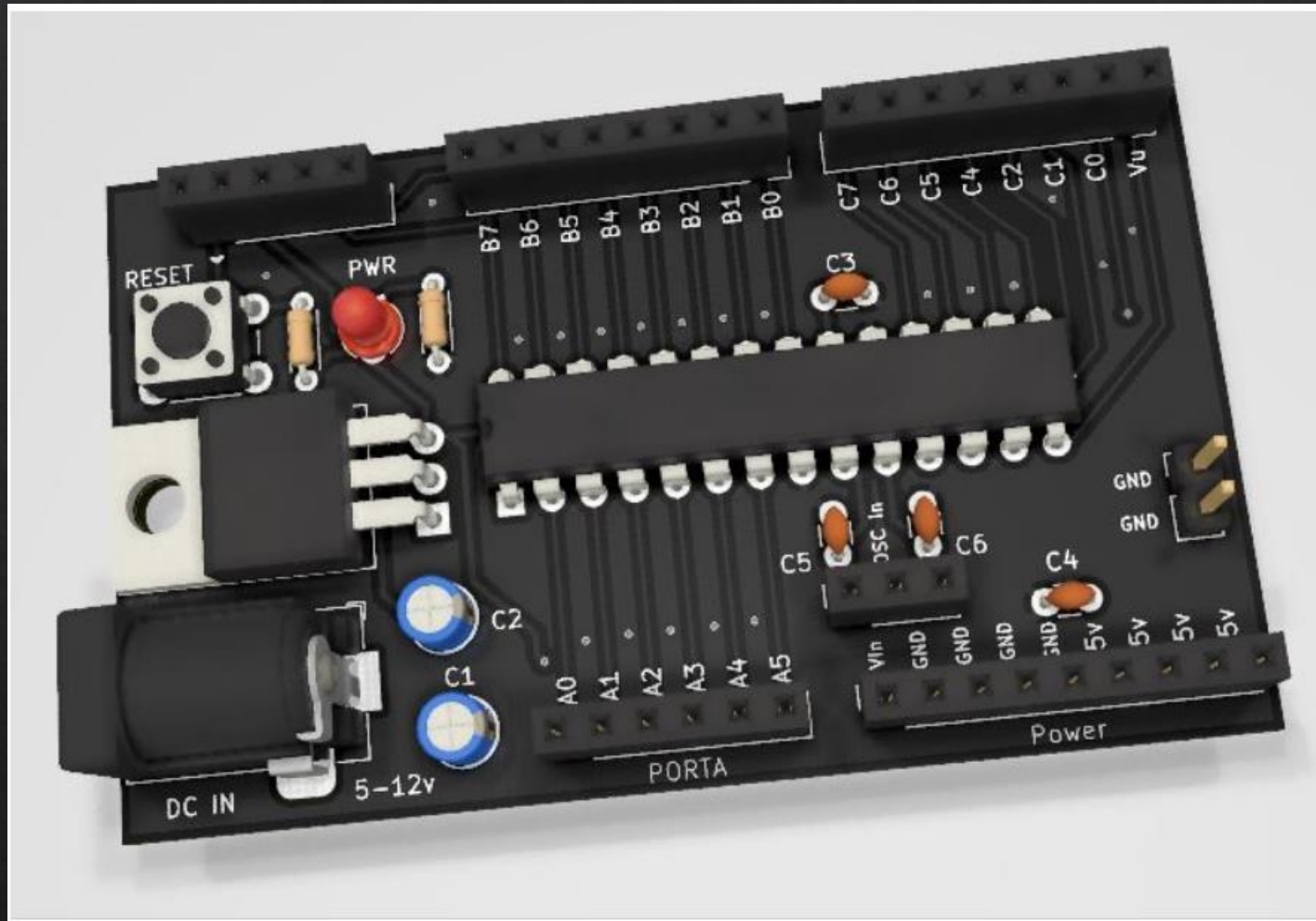
Assignment Footprint

Symbol : Footprint Assignments

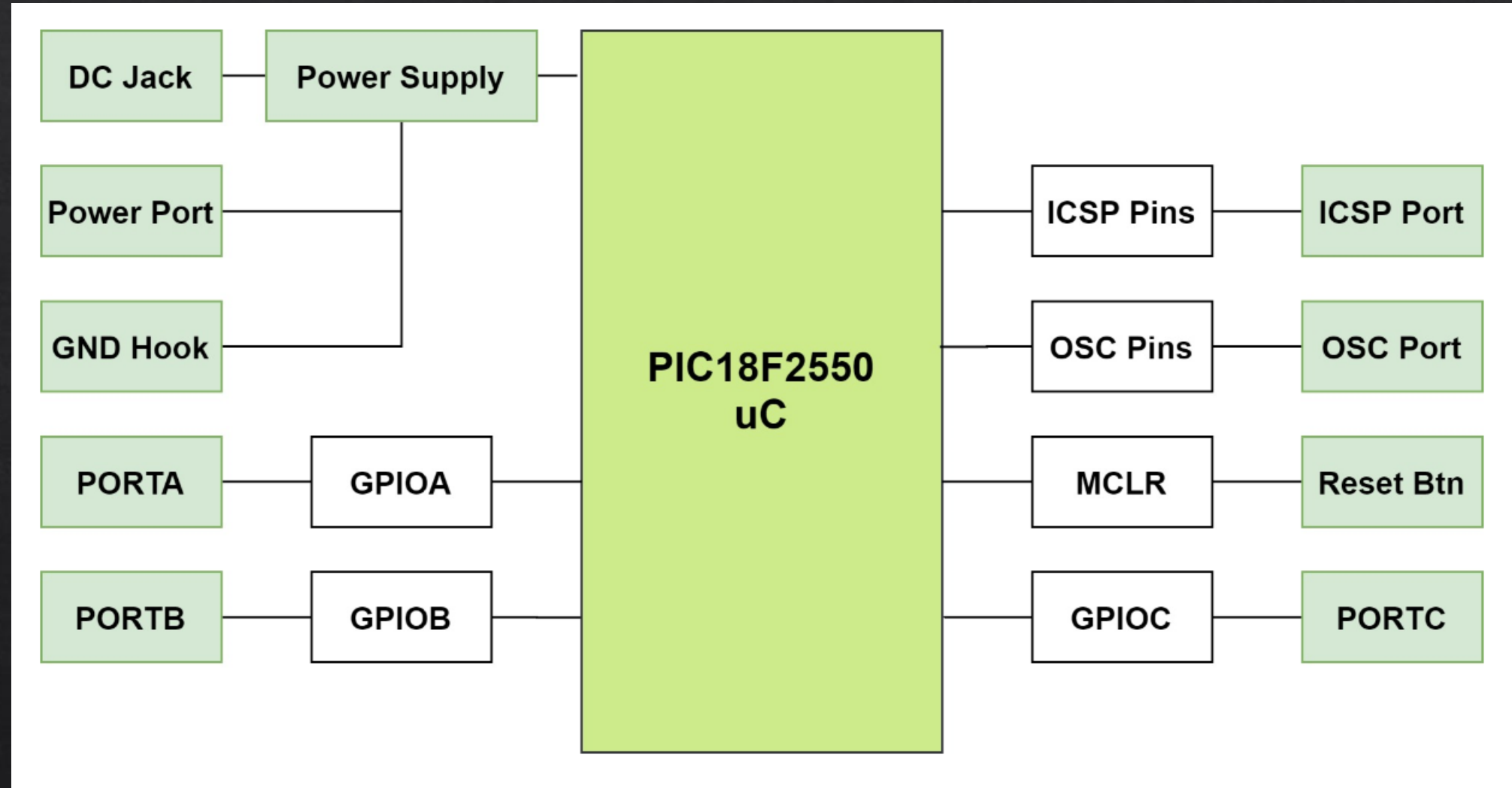
1	C1 -	CP1 : Capacitor_THT:C_Radial_D5.0mm_H5.0mm_P2.00mm
2	C2 -	CP1 : Capacitor_THT:C_Radial_D5.0mm_H5.0mm_P2.00mm
3	D1 -	D : Diode_THT:Diode_Bridge_DIP-4_W5.08mm_P2.54mm
4	D2 -	D : Diode_THT:Diode_Bridge_DIP-4_W5.08mm_P2.54mm
5	D3 -	D : Diode_THT:Diode_Bridge_DIP-4_W5.08mm_P2.54mm
6	D4 -	D : Diode_THT:Diode_Bridge_DIP-4_W5.08mm_P2.54mm
7	D5 -	LED : LED_THT:LED_D3.0mm
8	D6 -	LED : LED_THT:LED_D3.0mm
9	J1 - Barrel_Jack_Switch :	Connector_BarrelJack:BarrelJack_CUI_PJ-036AH-SMT_Horizontal
10	J2 - Conn_02x02_Odd_Even :	Connector_PinHeader_1.00mm:PinHeader_2x02_P1.00mm_Vertical
11	J3 - Conn_02x02_Odd_Even :	Connector_PinHeader_1.00mm:PinHeader_2x02_P1.00mm_Vertical
12	R1 -	R_Small : Resistor_THT:R_Axial_DIN0204_L3.6mm_D1.6mm_P5.08mm_Horizontal
13	R2 -	R_Small : Resistor_THT:R_Axial_DIN0204_L3.6mm_D1.6mm_P5.08mm_Horizontal
14	SW1 -	SW_SPDT : Button_Switch_THT:SW_DIP_SPSTx01_Slide_9.78x4.72mm_W7.62mm_P2.54mm
15	U1 -	LM7805_TO220 : Package_TO_SOT_THT:TO-220-3_Vertical

Project 4

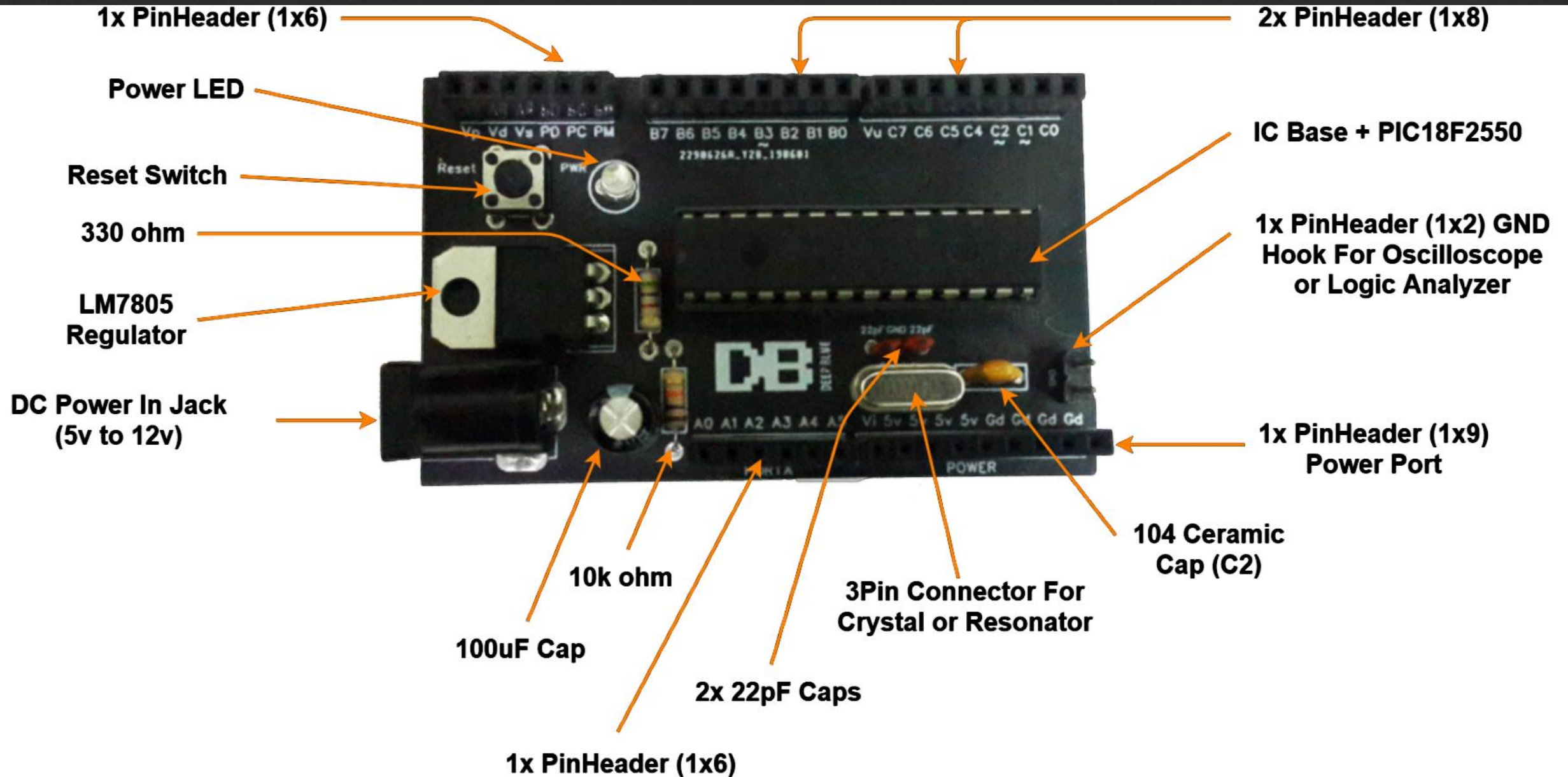
PIC18F Development Board



Project 4

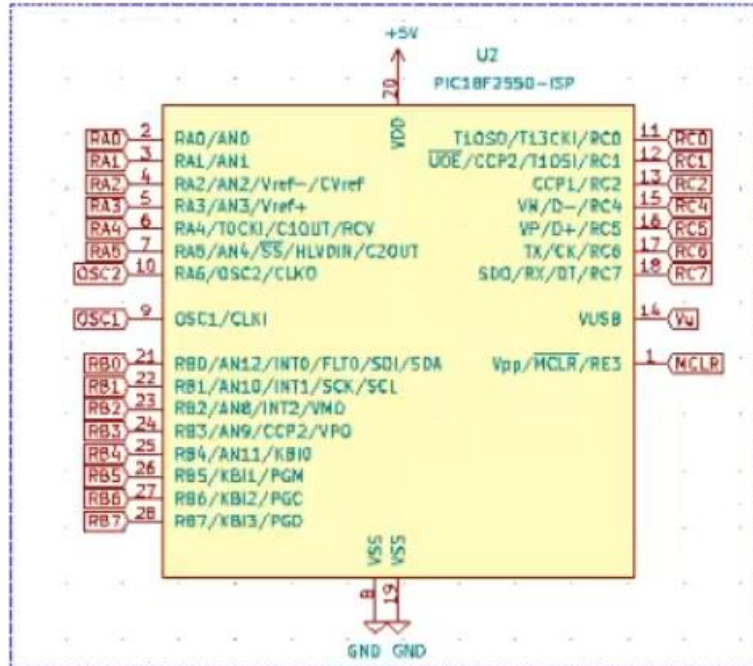


Project 4

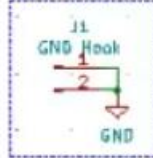


Schematic

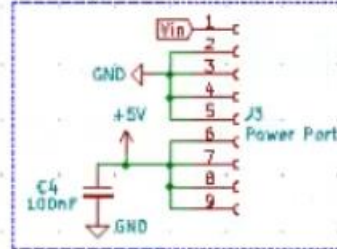
PIC18F2550 uC



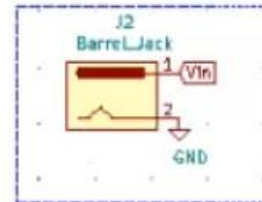
GND Hook



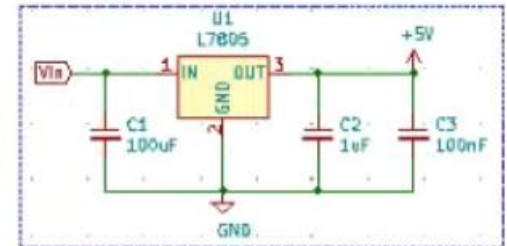
Power Port



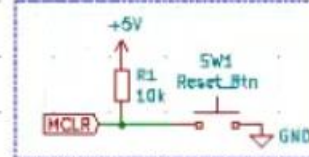
DC Jack



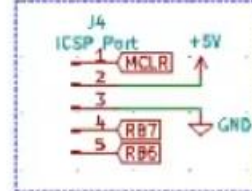
Power Supply (Regulator)



Reset Button



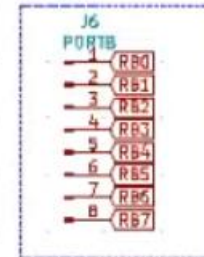
ICSP Port



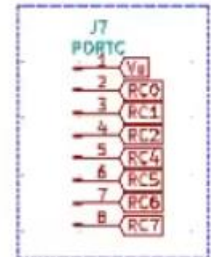
PORTA



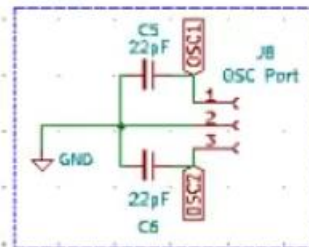
PORTB



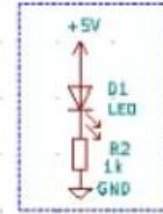
PORTC



OSC Port



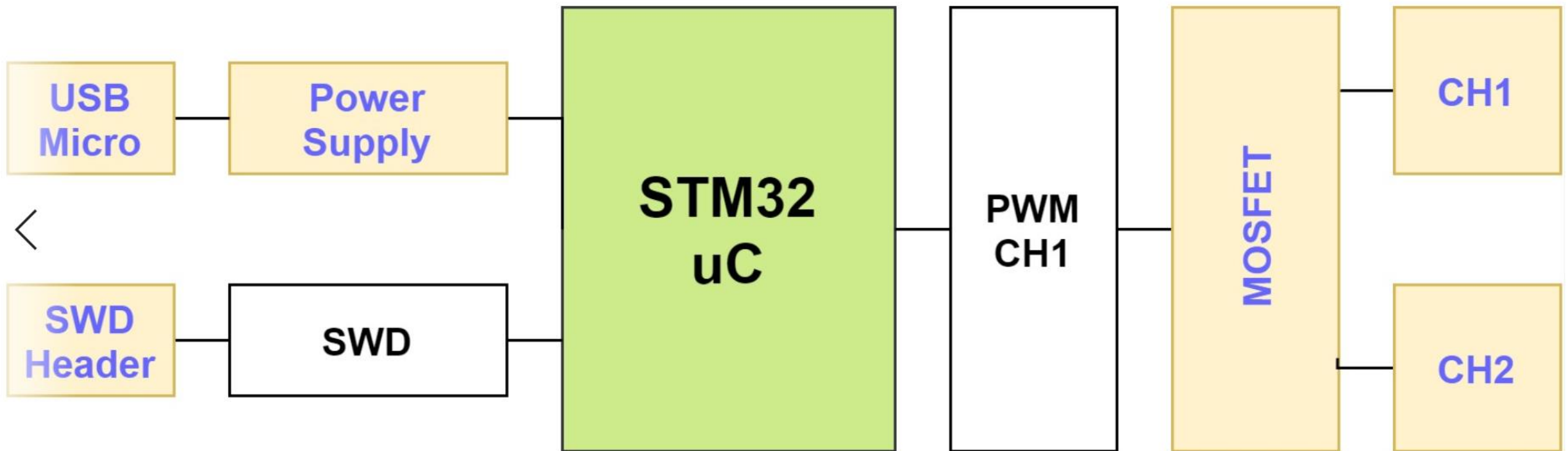
LED Power Indicator



Project 5



Top Level Design

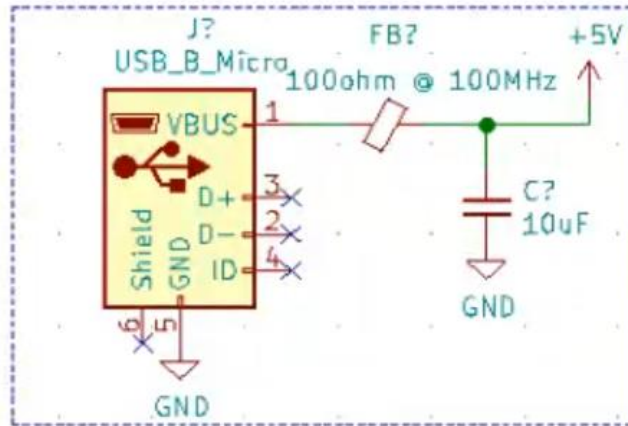


Functionality

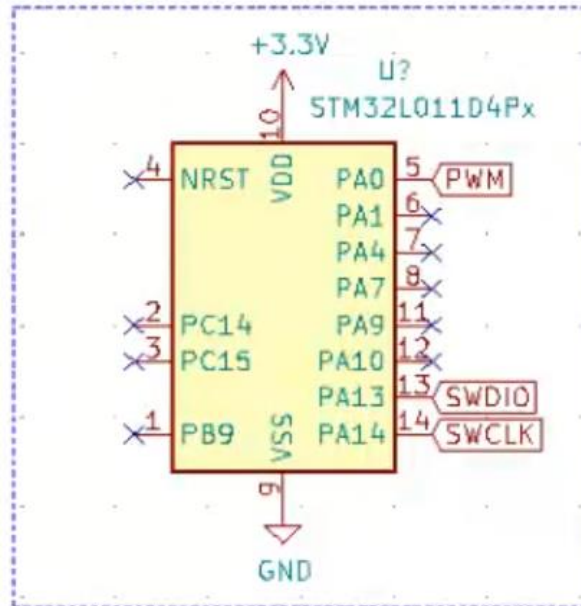


Schematic

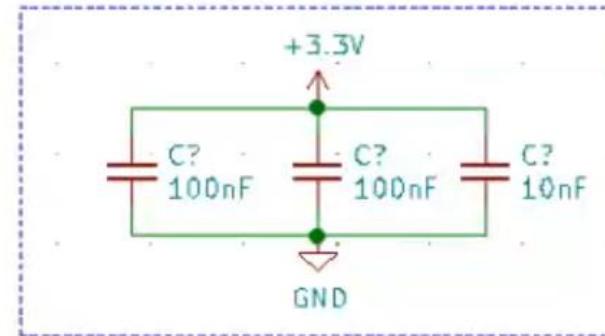
USB Power In



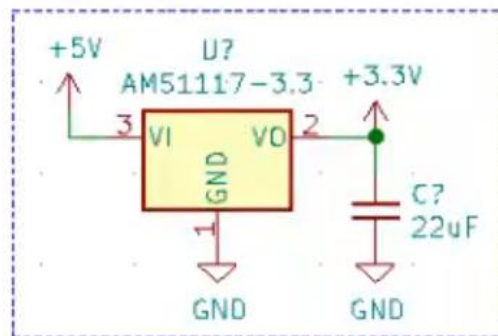
STM32 uC



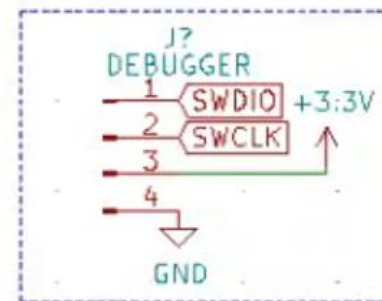
Power Supply Bypassing



Voltage Regulator



Debugger Port



MOSFET Output Driver

